

# 1.6 kW Titanium PSU with CoolMOS™ 600 V CFD7, Q-DPAK and XMC™

EVAL\_1K6W\_PSU\_CFD7\_QD

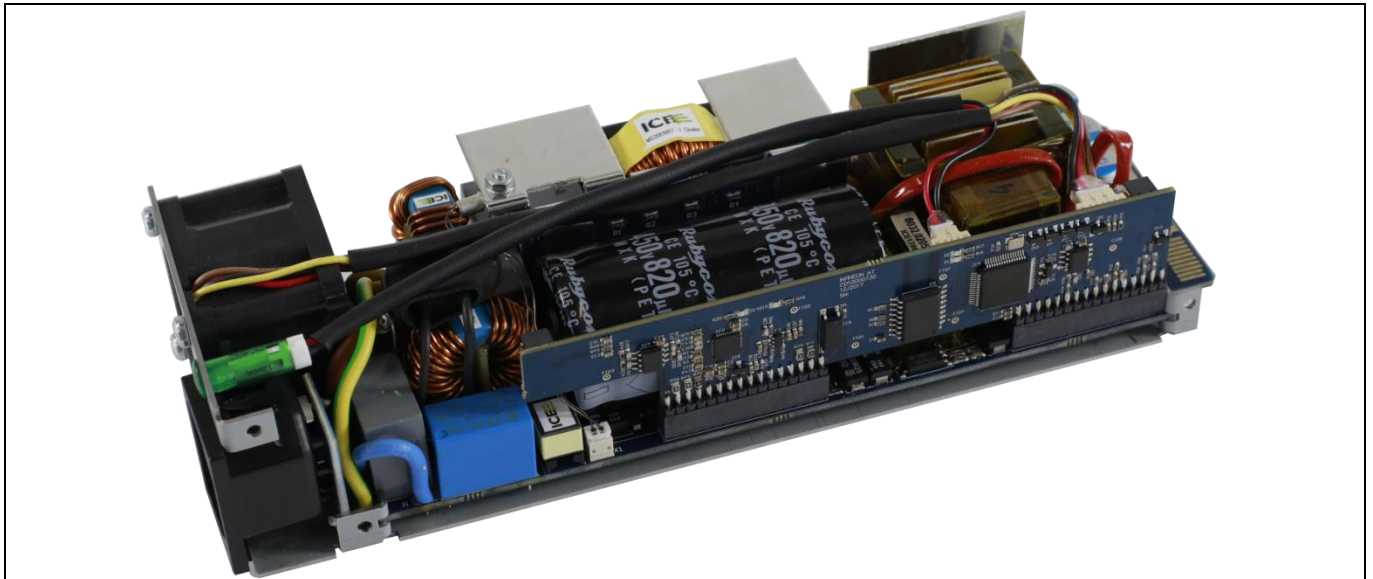
## About this document

### Scope and purpose

This application note describes a complete Infineon system solution for a 1600 W server power supply unit (PSU) which achieves the 80 PLUS Titanium standard. The EVAL\_1K6W\_PSU\_CFD7\_QD board is a server power supply composed of a continuous conduction mode (CCM) bridgeless power factor corrector (PFC) with bi-directional switch and a half-bridge LLC DC-DC resonant converter. This document presents the board using CoolMOS™ MOSFETs and CoolSiC™ Schottky diodes in top-side cooled SMD package (Q-DPAK and D-DPAK) as well as the specifications and the main results obtained during the test of the 1600 W server PSU.

The Infineon components used in this 1600 W server PSU are:

- CoolMOS™ 600 V G7 in D-DPAK, 600 V CoolMOS™ CFD7 in Q-DPAK superjunction (SJ) MOSFETs, and 650 V CoolSiC™ G6 Schottky diode in D-DPAK
- OptiMOS™ 6 40 V MOSFET
- EiceDRIVER™ 1EDI20N12AF isolated and 2EDN7524F non-isolated gate drivers
- XMC1402 and XMC4200 microcontrollers
- CoolSET™ ICE2QR2280G Quasi Resonant (QR) flyback controller



**Figure 1** 1600 W Titanium server power supply with top-side cooled CoolMOS™ and CoolSiC™

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## EVAL\_1K6W\_PSU\_CFD7\_QD

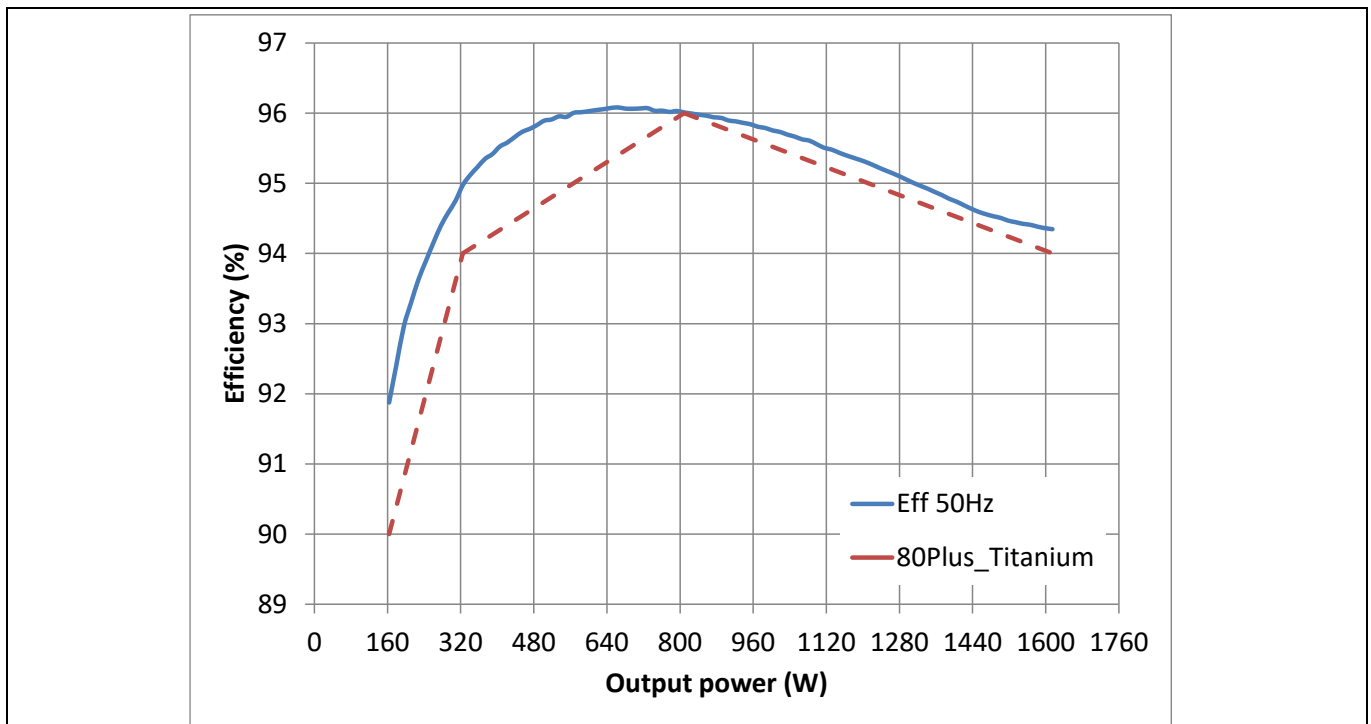
### Background and system description

## 1 Background and system description

The trend in SMPS in recent years has been towards increased power density with optimized cost. For achieving this higher power density, high efficiency is a key parameter to minimize heat dissipation. Infineon's 800 W server power supply unit (PSU) ([1] and [2]) demonstrates achievable efficiency levels, outperforming 80 PLUS Platinum efficiency. However, if higher power is needed with the same form factor, thus increasing the power density, an even higher efficiency is required to further reduce the heat dissipation and make the design thermally feasible.

The 1600 W server PSU (EVAL\_1K6W\_PSU\_CFD7\_QD Evaluation Board) complies with 80 PLUS Titanium as shown in Figure 2. The top-side cooling (TSC) packages (D-DPAK and Q-DPAK), allow keeping the same form factor as the previously introduced 800 W server PSU. Therefore, the power density is increased to 44 W/in<sup>3</sup> for the 1600 W power supply design.

*Note: Due to production variations and measurement setup, efficiency variations up to ±0.2 percent could occur with respect to the results shown.*



**Figure 2 Measured efficiency of the 1600 W server PSU complying with the Titanium efficiency standard**

The efficiency shown can be achieved by using the CoolMOS™ 600 V CFD7 and G7 together with CoolSiC™ 650 V G6 Schottky diodes. The outstanding performance of these semiconductor technologies, together with the D-DPAK and Q-DPAK SMD packages with top-side cooling, enables an efficient system thinking [3] and [4].

The devices used in the implementation of EVAL\_1K6W\_PSU\_CFD7\_QD server PSU are:

- CoolMOS™ 600 V, 75 mΩ CFD7 in Q-DPAK TSC package (IPDQ60R075CFD7) and 8 A 650 V CoolSiC™ G6 Schottky diodes in D-DPAK TSC package (IDDD08G65C6), for PFC

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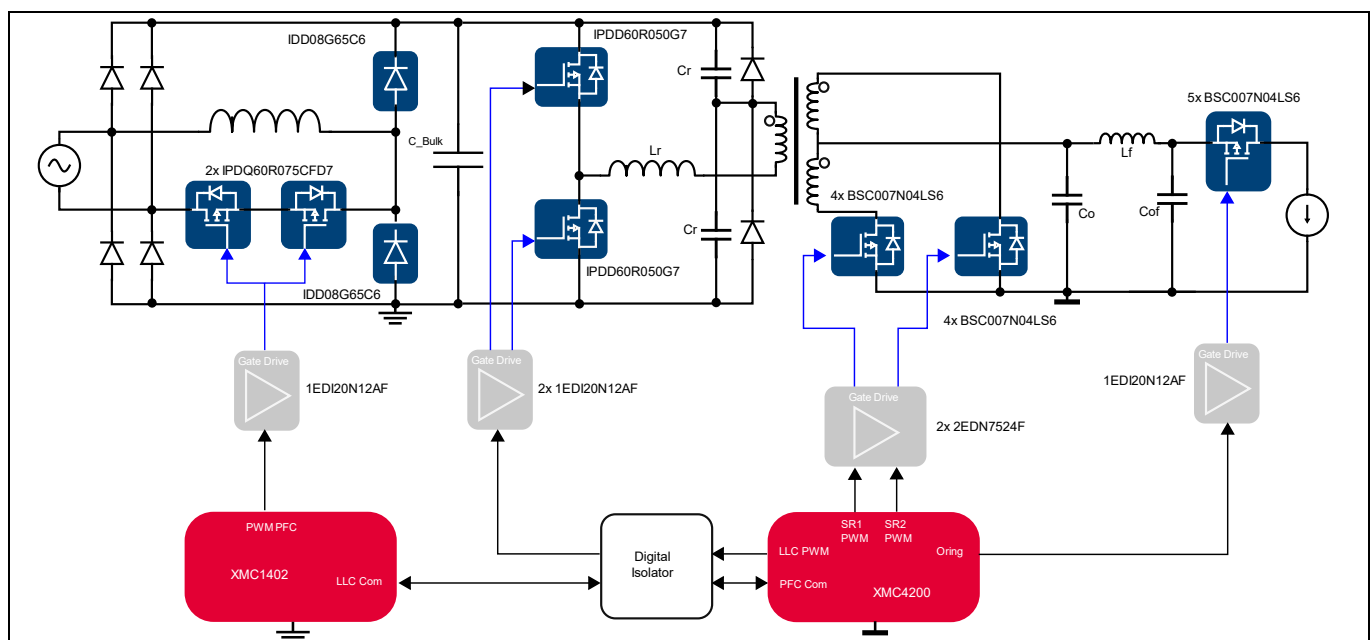
- CoolMOS™ 600 V, 50 mΩ G7 in D-DPAK TSC package (IPDD60R050G7) and OptiMOS™ 6 40 V, 7 mΩ in Super SO-8 package (BSC007N04LS6) for LLC
- OptiMOS™ 6 40 V, 7 mΩ in Super SO-8 package (BSC007N04LS6) as O-ring switch
- EiceDRIVER™ 1EDI20N12AF isolated and 2EDN7524F non-isolated gate drivers
- ICE2QR2280G QR flyback controller with integrated CoolMOS™ 800 V for the bias auxiliary supply
- XMC1402 (PFC) and XMC4200 (LLC) microcontrollers for control implementation

This document will describe the system and board of the 1600 W server SMPS, as well as the specifications and main test results. For more information on Infineon semiconductors, see the [Infineon](#) website as well as the Infineon [evaluation board](#) search and the different websites for the different implemented components:

- [CoolMOS™](#) power MOSFETs
- [OptiMOS™](#) power MOSFETs
- [CoolSiC™](#) Schottky diodes
- [Gate driver ICs](#)
- [QR CoolSET™](#)
- [XMC™](#) microcontrollers

## 1.1 System description

The EVAL\_1K6W\_PSU\_CFD7\_QD design consists of a bridgeless PFC with a bi-directional switch [8] as the AC-DC stage and a half-bridge LLC with Synchronous Rectification (SR) as the DC-DC stage (Figure 3). The power supply has been designed to comply with the requirements of a datacenter server operation.



**Figure 3** Simplified diagram of 1600 W Titanium server PSU with D-DPAK and Q-DPAK TSC (EVAL\_1K6W\_PSU\_CFD7\_QD) Infineon power semiconductors.

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The PFC stage is operated exclusively at high-line (176 Vrms minimum, 230 Vrms nominal) in CCM with a switching frequency of 65 kHz. The bulk capacitance is designed to comply with 10 ms hold-up time (Table 1). The PFC function to achieve bulk voltage control at an adequate level for the DC-DC converter, while demanding high-quality current from the grid, is implemented in an Infineon XMC1402 microcontroller. For more information on PFC control implementation in the XMC™ 1000 family, see [1], [2], [5], and [6].

The DC-DC stage is an LLC resonant topology with center-tapped transformer and SR. The resonant frequency of the implemented resonant tank is 160 kHz and the operating switching frequency is allowed to move in the range from 52 kHz to 300 kHz. The targeted output voltage is 12.2 V with a nominal output current of 132 A. The LLC control is implemented in an XMC4200 Infineon microcontroller, which includes voltage regulation, burst mode operation, output overcurrent protection (OCP) and overvoltage protection (OVP), and timer configuration for CoolMOS™ and OptiMOS™ safe operation. For more information on digital control implementation of LLC in the XMC™ 4000 family, see [1], [2], and [7].

O-ring switches are mounted for efficiency consideration of the full system solution. However, no advance O-ring function is included in the control implementation. Furthermore, an I<sup>2</sup>C channel is reserved in the secondary controller, which would enable PM-Bus communication.

## 1.2 Board description

Figure 4 shows a placement of the different sections of the EVAL\_1K6W\_PSU\_CFD7\_QD server PSU with Infineon D-DPAK and Q-DPAK power semiconductors.

### Board specifications:

- **Length:** 19.3 cm
- **Width:** 7 cm
- **Height:** 4.4 cm
- **Power density:** 44 W/in<sup>3</sup>

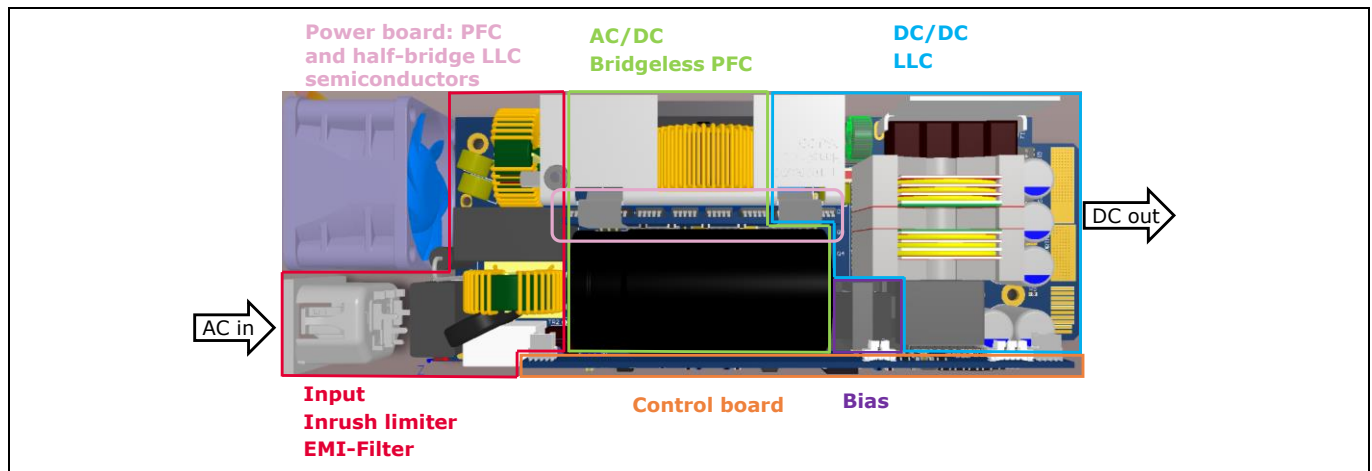
### Component placement:

On the left, the fuse and the NTC inrush current limiter are placed together with the input relay immediately after the AC input connector. This is followed by a two-stage EMI filter. In the middle section, the AC-DC stage and the bulk capacitor are placed. On the right side, the DC-DC converter, the O-ring switches and the output connector are placed. The bias converter generates the required supplies for the driving and control circuitry. The control board is placed along the side of the power supply. The power semiconductors in TSC packages of the PFC and primary half-bridge of the LLC are placed in a power board attached to a heatsink, as shown in the pink area of Figure 4.

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### Background and system description

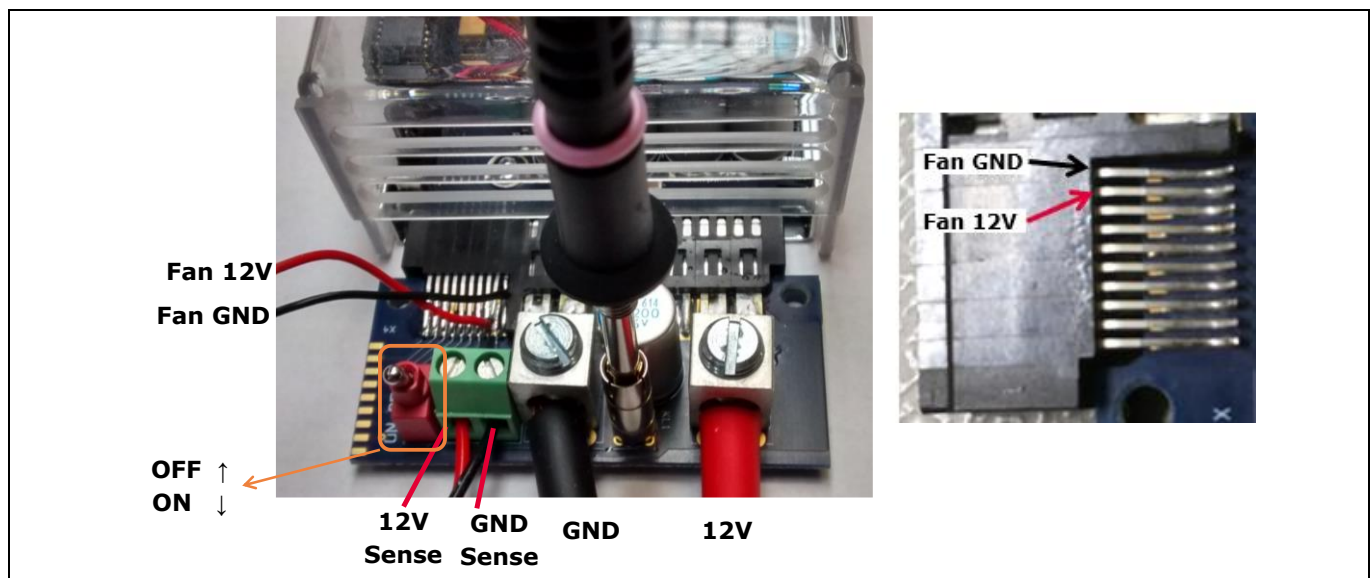


**Figure 4** Placement of the different sections in the 1600 W PSU with Infineon TSC CoolMOS™ and CoolSiC™

### 1.2.1 Output connector

EVAL\_1K6W\_PSU\_CFD7\_QD includes a host board for the output connector, as for the Infineon 800 W server power supply evaluation board [1]. This board includes power connectors and a sensing point for the output voltage as well as a switch for remote on-off (Figure 5 – left). The voltage of the sensing connection (12 V sense – GND sense) is the one used for DC output regulation and can be used for output sensing in external equipment.

Furthermore, the host board enables the connection of the output voltage terminals to the fan supply (Fan 12 V – Fan GND). However, an external fan supply is only possible by directly accessing the connector pin. In that case, the second pin of the signal connector (Fan 12 V in Figure 5 – right) must be lifted to provide the proper fan supply voltage.



**Figure 5** Output connector PCB with the connections and remote on/off switch (left) and detail of fan connection pins (right).

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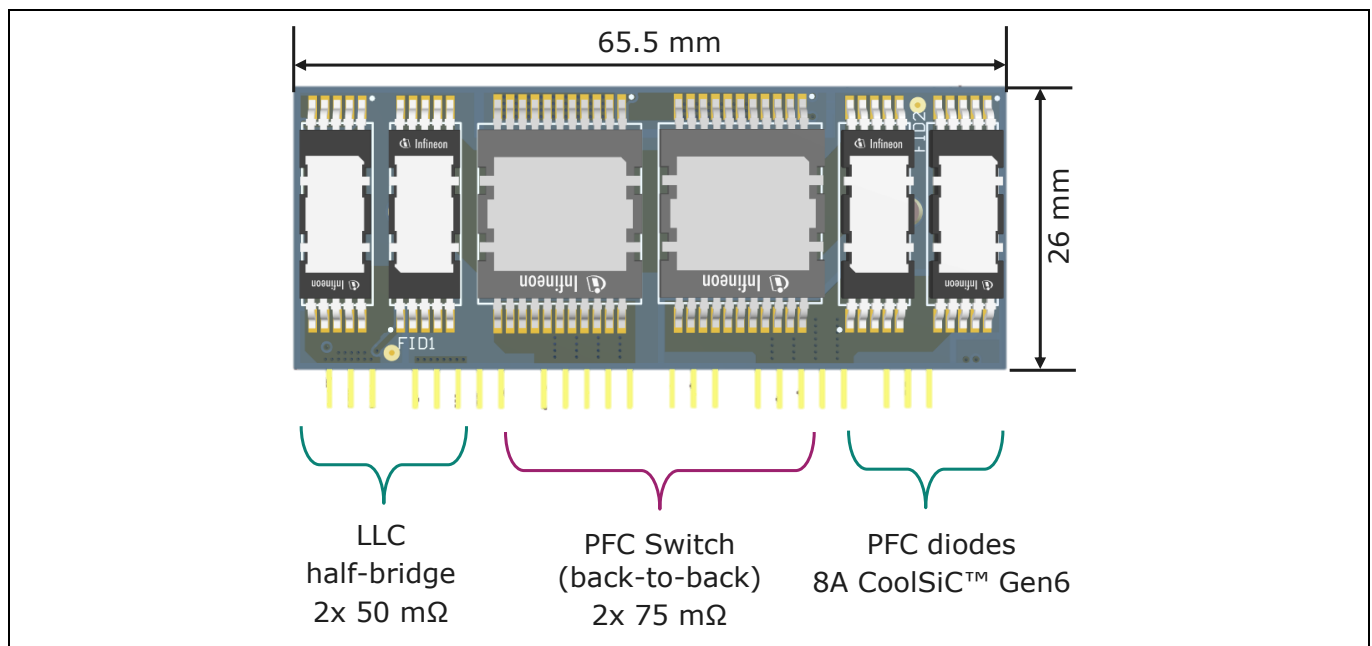
### Background and system description

### 1.3 Power board with TSC (D-DPAK/Q-DPAK) power semiconductors

The use of the top-side cooled D-DPAK and Q-DPAK packages enable different system thinking and the inclusion of SMD packages in high-power SMPS applications ([3] and [4]) as shown in Figure 4.

The use of CoolMOS™ G7 and CFD7 transistors in both PFC and LLC allow loss reduction due to improvement of different figures of merit [3], [4]. Furthermore, the forward voltage in the CoolSiC™ G6 diode is reduced, contributing to lower diode losses [3]. The lower losses together with an improved thermal resistance, which compensates the lower dissipation area in respect to leaded packages, and the low profile of the top-side cooled SMD package, enable mounting of the PFC and half-bridge switches to share the same heatsink.

The use of a power board (Figure 6) enables an increase of power density, while having optimized commutation loops and therefore, low parasitic inductances. This power board, which mounts the PFC CoolMOS™ CFD7 switches and CoolSiC™ G6 Schottky diodes, together with the LLC CoolMOS™ G7 half-bridge switches, is vertically placed in the central part of the PSU in front of the fan (the pink area in Figure 4). In this case, six parts are soldered to the power board and share the same heatsink, which is attached by using pressure clips as shown in Figure 7. The heatsink includes an NTC for monitoring the temperature for protection and for adapting the fan speed.

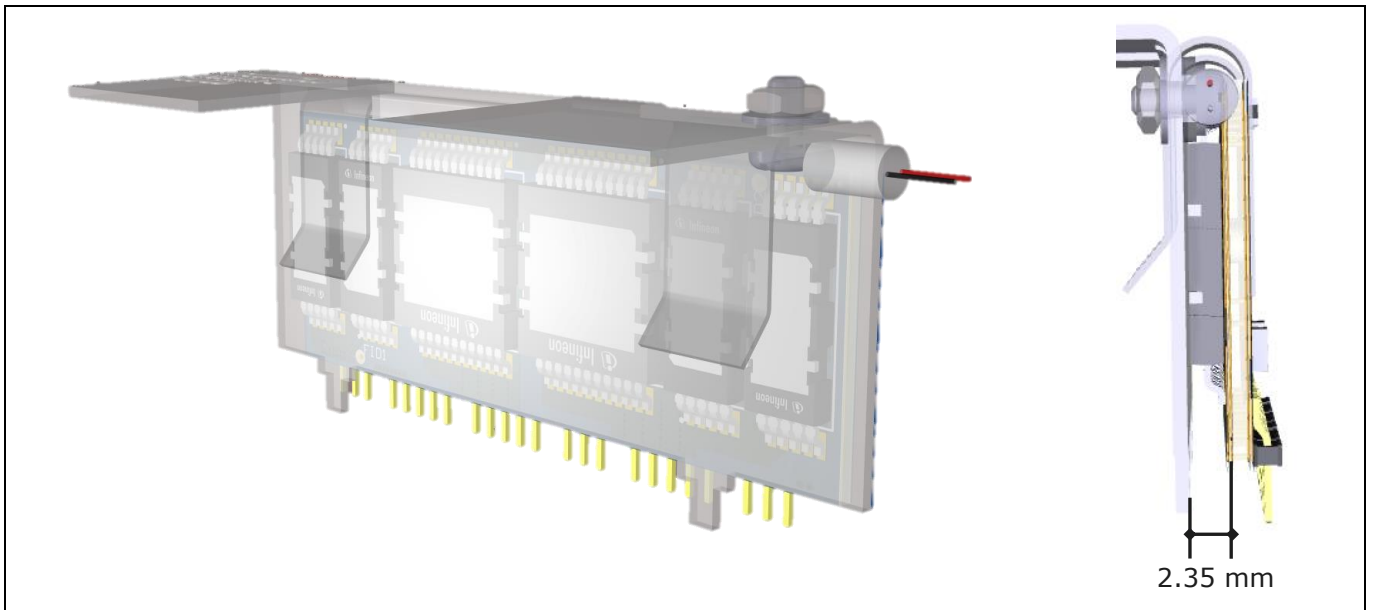


**Figure 6 Power board mounting the Infineon D-DPAK and Q-DPAK semiconductors for the PFC and half-bridge LLC**

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### Background and system description



**Figure 7** Heatsink mounting for the power board of EVAL\_1K6W\_PSU\_CFD7\_QD



## 2 Specification and test results

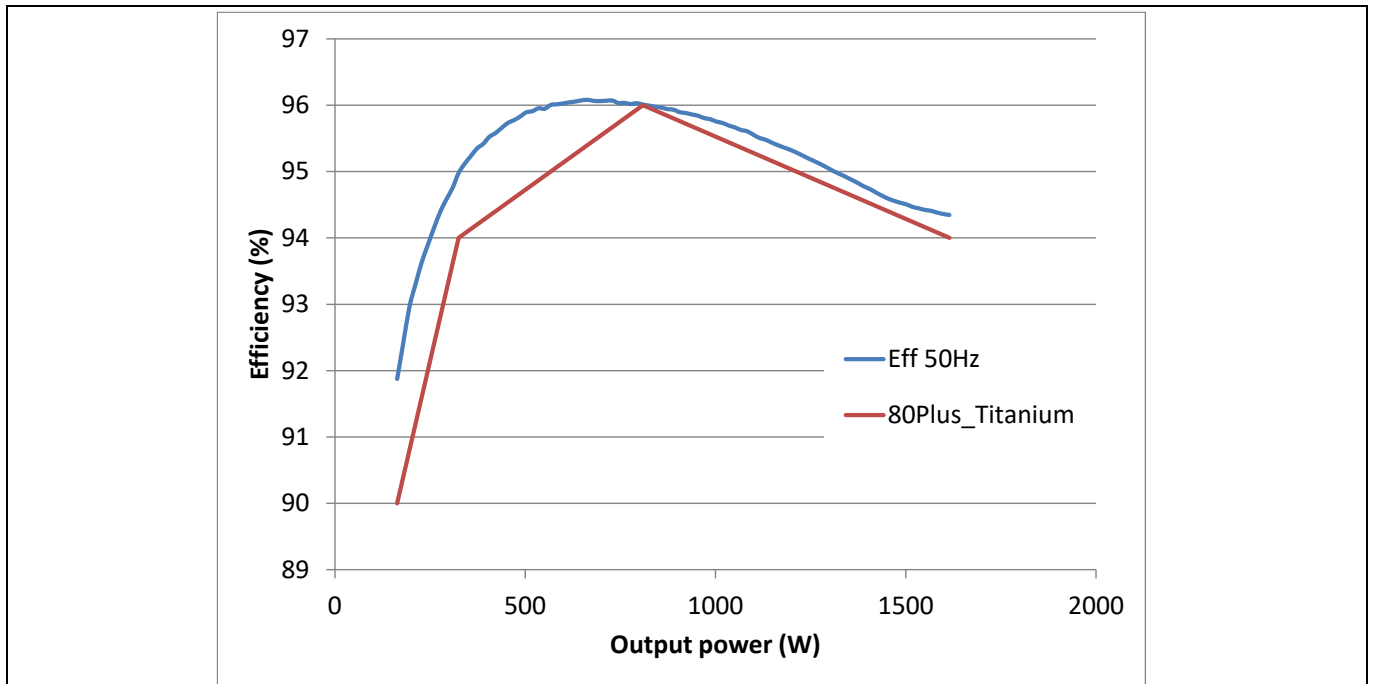
This chapter presents the specifications, performance, and behavior of the 1600 W server PSU developed using CoolMOS™ in TSC package. [Table 1](#) shows the demonstrator performance and specifications under several steady-state and dynamic conditions.

**Table 1 Summary of specifications and test conditions for the 1600 W PSU**

| Test                          |                        | Conditions   | Specification  |  |
|-------------------------------|------------------------|--|--|--|
| Efficiency test               |                        | 230 Vrms, 50 Hz/60 Hz, 10 percent to 100 percent load                | 80 PLUS Titanium efficiency.<br>$\eta_{pk} = 96$ percent at 800 W (50 percent load)                    |  |
| Current THD                   |                        | 230 Vrms, 50 Hz/60 Hz, 10 percent to 100 percent load                | THDi less than 10 percent from 20 percent load   |  |
| Power factor                  |                        | 230 Vrms, 50 Hz/60 Hz, 10 percent to 100 percent load                | PF more than 0.95 from 20 percent load   |  |
| Output voltage                |                        | –  | 12.2 V   |  |
| Steady-state $V_{out}$ ripple |                        | 230 Vrms, 50 Hz/60 Hz, 10 percent to 100 percent load                | $ \Delta V_{out} $ less than 120 mV <sub>pk-pk</sub>   |  |
| Inrush current                |                        | 230 Vrms, 50 Hz/60 Hz, measured on the first AC cycle                | $I_{in\_peak}$ less than 30 A  |  |
| Power line disturbance        | AC lost (hold-up time) | 230 Vrms, 50 Hz, 10 ms at 100 percent load, 20 ms at 50 percent load | $ \Delta V_{out} $ less than 240 mV <sub>pk</sub>  | No damage:<br>* PSU soft-start if bulk voltage under 310 V<br>* PSU soft-start if V AC out of range for certain time |
|                               | Voltage sag            | 200 Vrms, 50Hz/60Hz, different sag conditions, 100 percent load      |  |  |
| Brown-out                     |                        | –  | 174 V on; 168 V off  |  |
| Load transient                |                        | 1 A ↔ 66 A, 0.5 A/μs   | $ \Delta V_{out} $ less than 240 mV <sub>pk</sub>  |  |
|                               |                        | 66 A ↔ 133 A, 0.5 A/μs   |  |  |
| OCP                           |                        | 30 s at 141 A  | LLC off  |  |
|                               |                        | 10 s at 149 A  | Resume of operation requires bulk voltage to drop under 310 V  |  |
|                               |                        | 1 ms at 168 A  |  |  |
|                               |                        | Output terminals in short-circuit                                    | Detection within switching cycle.<br>Resumption of operation requires bulk voltage to drop under 310 V |  |
| EMI conducted                 |                        | 230 Vrms, 50 Hz, full load, resistive load, lab setup                | Complies with Class B limits   |  |

### 2.1 Performance and steady-state waveforms

In this chapter, the steady-state waveforms are presented together with the efficiency and the Power Factor (PF) and THD achieved in the 1600 W server PSU presented in this application note. The PSU operates only in high-line (from 176 V to 265 V line voltage) with a nominal input voltage of 230 Vrms. Therefore, the efficiency is presented for this nominal voltage. As shown in [Figure 8](#), the Infineon 1600 W PSU with TSC CoolMOS™ CFD7 and G7 and CoolSiC™ G6 achieves Titanium efficiency.



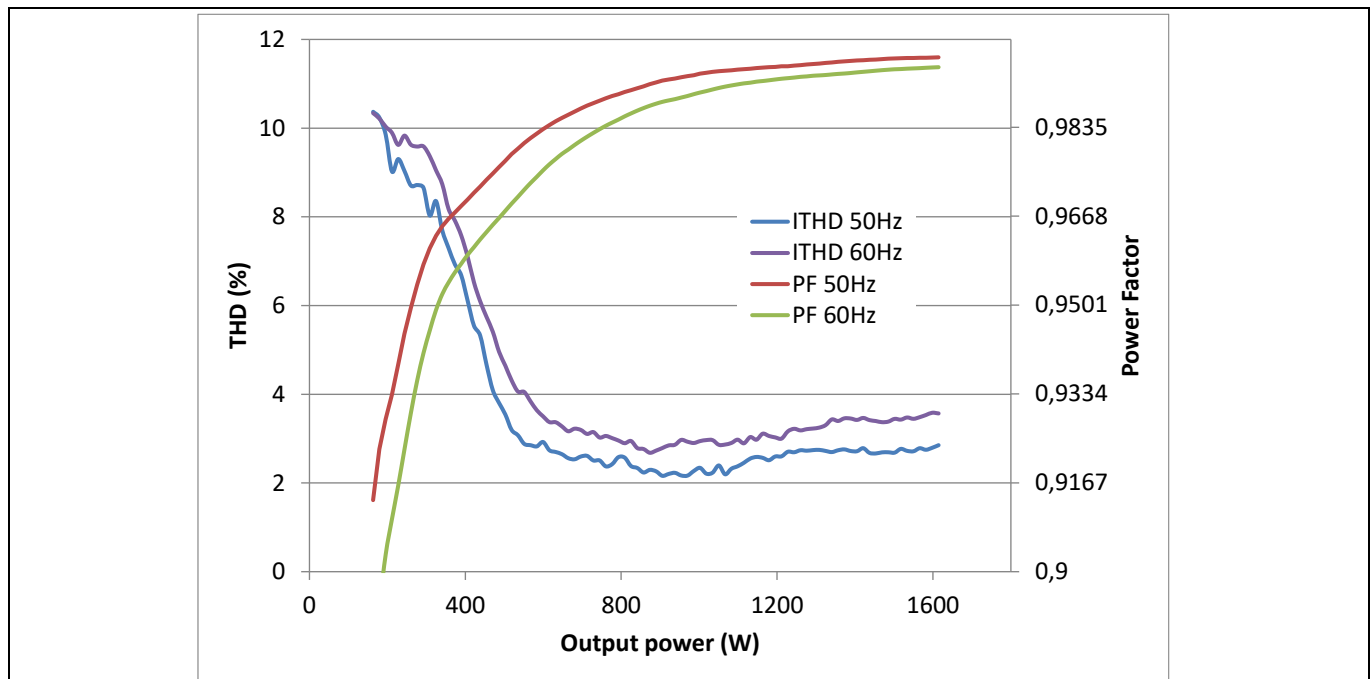
**Figure 8** Measured efficiency at 230 V 50 Hz input voltage

[Figure 9](#) depicts the measured PF and THD. The achieved PF is over 0.95 when the output power is higher than the 20 percent of the nominal output power, i.e., 320 W, for both 50 Hz and 60 Hz input voltage. In the case of the THD, the distortion is under 10 percent for output power over the 20 percent level for both 50 Hz and 60 Hz input voltage.

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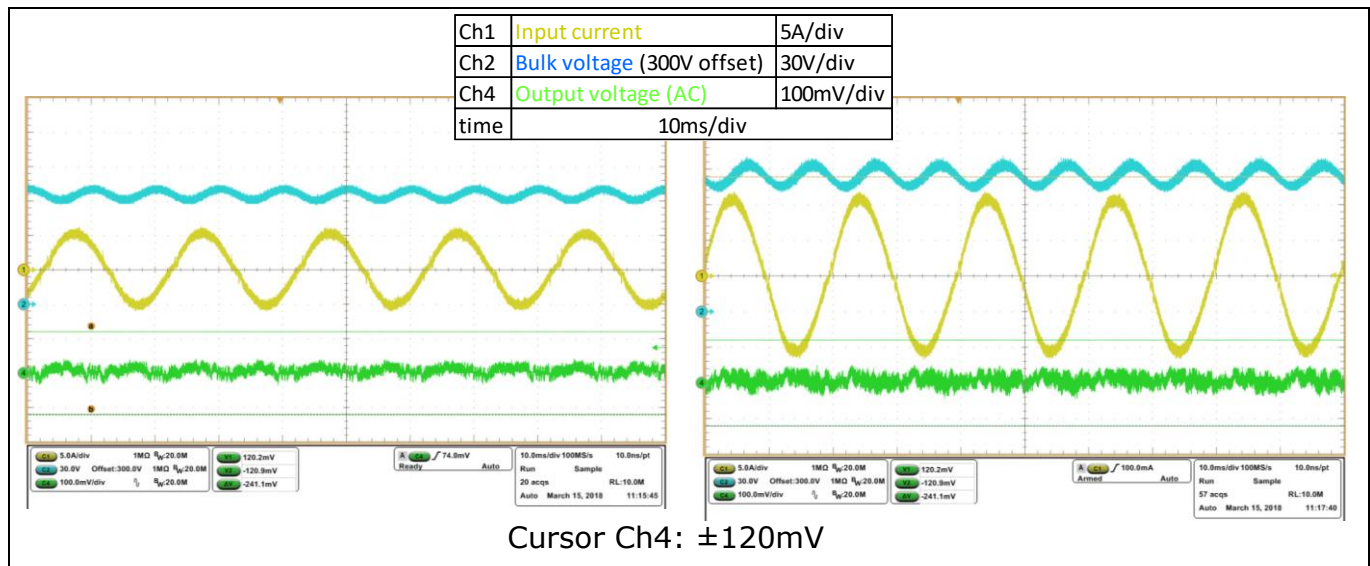
EVAL\_1K6W\_PSU\_CFD7\_QD

Specification and test results



**Figure 9** Measured THD and power factor at 230 V input voltage for both 50 Hz and 60 Hz

The main waveforms of the PSU are presented for different output power levels for 50 Hz (Figure 10) and 60 Hz (Figure 11) at nominal input voltage. As it can be seen, the input current presents low distortion according to the previously presented curve and the output voltage ripple is under the specified  $\pm 120$  mV range.

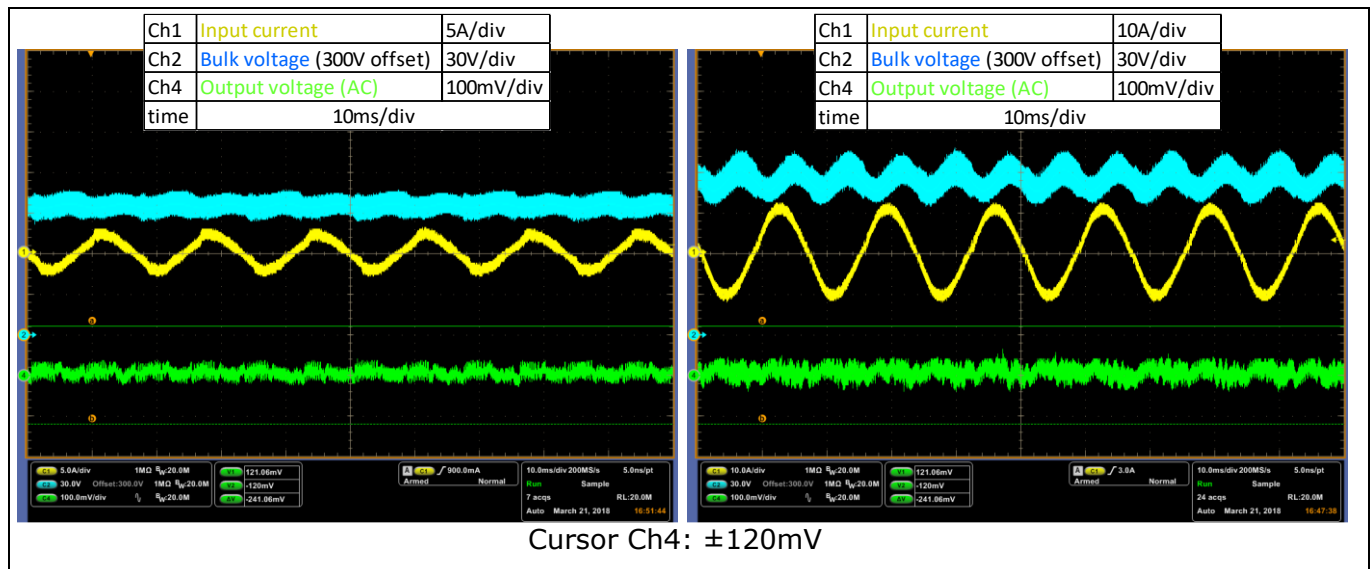


**Figure 10** Steady-state waveforms at 230 V 50 Hz for 50 percent load (left) and 100 percent load (right)

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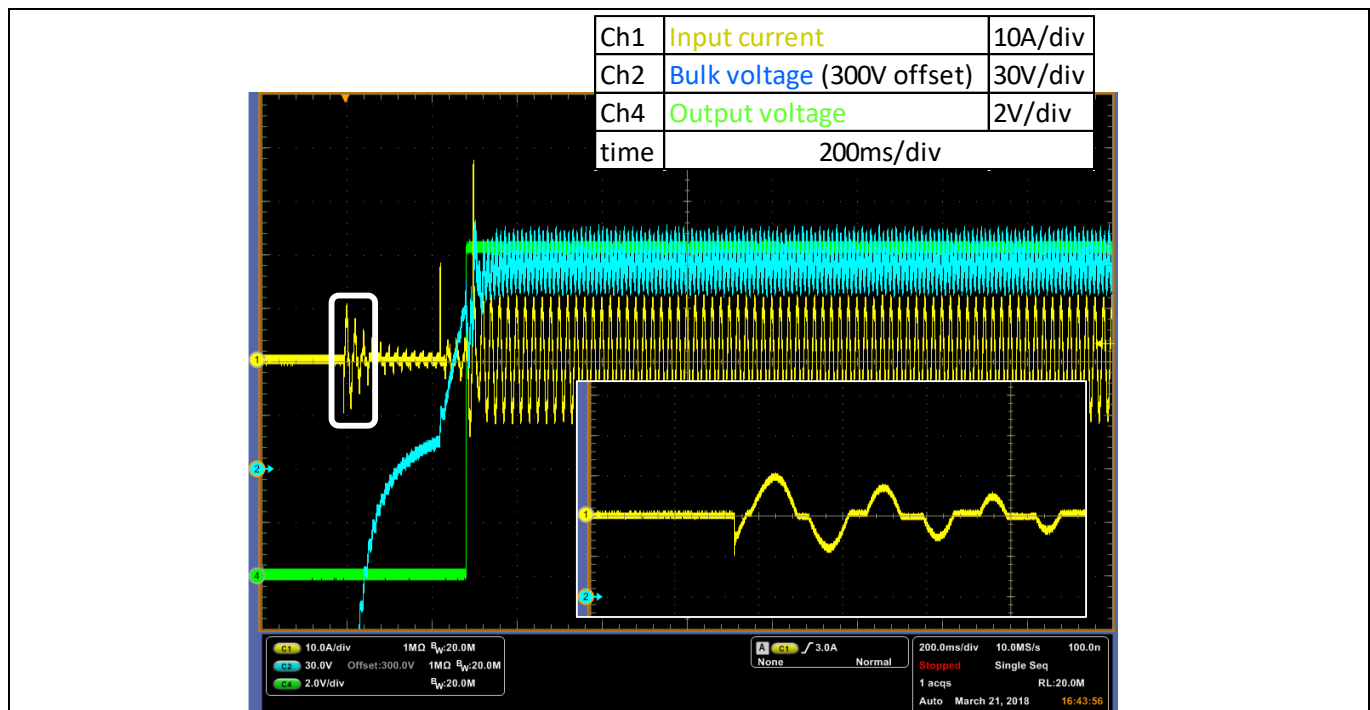
### Specification and test results



**Figure 11** Steady-state waveforms at 230 V 60 Hz for 20 percent load (left) and 100 percent load (right)

## 2.2 Inrush current

In the PSU, the inrush current when connecting to the AC source is limited with an NTC. This resistor is short-circuited by a parallel relay before start-up if the input and output voltage conditions to start the PFC are met. The inrush current is measured at the first AC cycle and it is independent on the output load. In [Figure 12](#), the full-load start-up of the server PSU is presented and the inrush current is highlighted. According to the measurement, the inrush current is significantly under the specified 30 A in [Table 1](#).



**Figure 12** Inrush current of the 1600 W server PSU at full-load start-up

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### Specification and test results

## 2.3 Power line disturbance

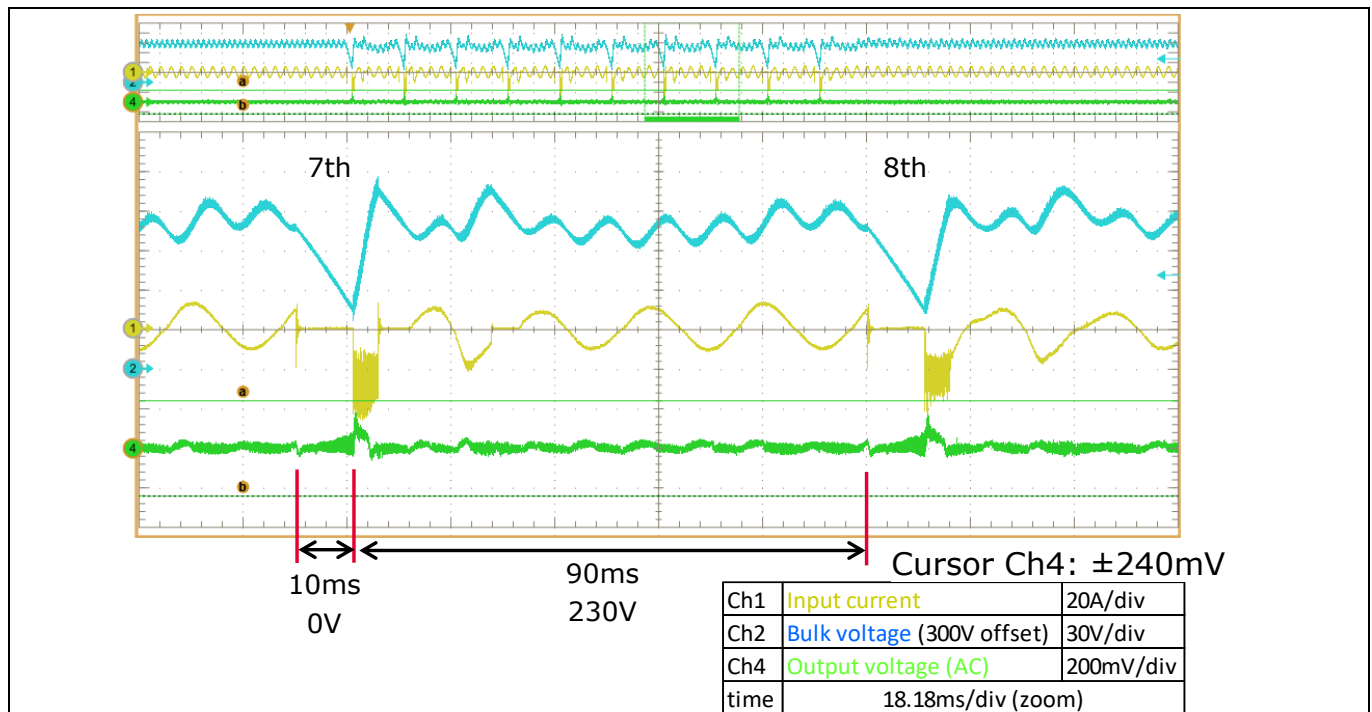
Two main line disturbance conditions can occur when connected to the grid. On one side, the AC can be lost during a certain time – Line Cycle Drop Out (LCDO) – and on the other side, the AC voltage can suddenly decrease to an abnormal value – voltage sag. This section introduces the test conditions for both disturbances as well as the SMPS performance when those conditions are applied using a programmable AC source.

### 2.3.1 Line cycle drop-out

The 1600 W power supply operates exclusively in high-line. Therefore, the AC LCDO capability is tested from 230 V to 0 V. Different timing, related to the specified hold-up time and the line frequency is applied as shown in Table 2. The test results (Figure 13 and Figure 14) show that the output voltage is within the specified dynamic variation regardless of the start angle of the voltage drop-out. In case the drop-out is longer than specified, output voltage regulation can be lost, and even a turn-off and restart of the unit is possible if the bulk voltage falls to 310 V.

**Table 2 Applied voltage cycles for LCDO test at different loads with 50 Hz AC input voltage**

|                                     | 1 <sup>st</sup> to 10 <sup>th</sup> time (100 ms period) |                    |                    |
|-------------------------------------|--|--------------------|--------------------|
| Applied voltage                     | 230 V AC   | 0 V AC             | 230 V AC           |
| Timing at different load conditions | 50 percent load  | 20 percent (20 ms) | 80 percent (80 ms) |
|                                     | 100 percent load   | 10 percent (10 ms) | 90 percent (90 ms) |



**Figure 13 Detail of the 7<sup>th</sup> and 8<sup>th</sup> repetition in a 10 ms LCDO test at 230 V AC, 50 Hz and 100 percent load with a starting angle of 45 degrees**

EVAL\_1K6W\_PSU\_CFD7\_QD  
Specification and test results

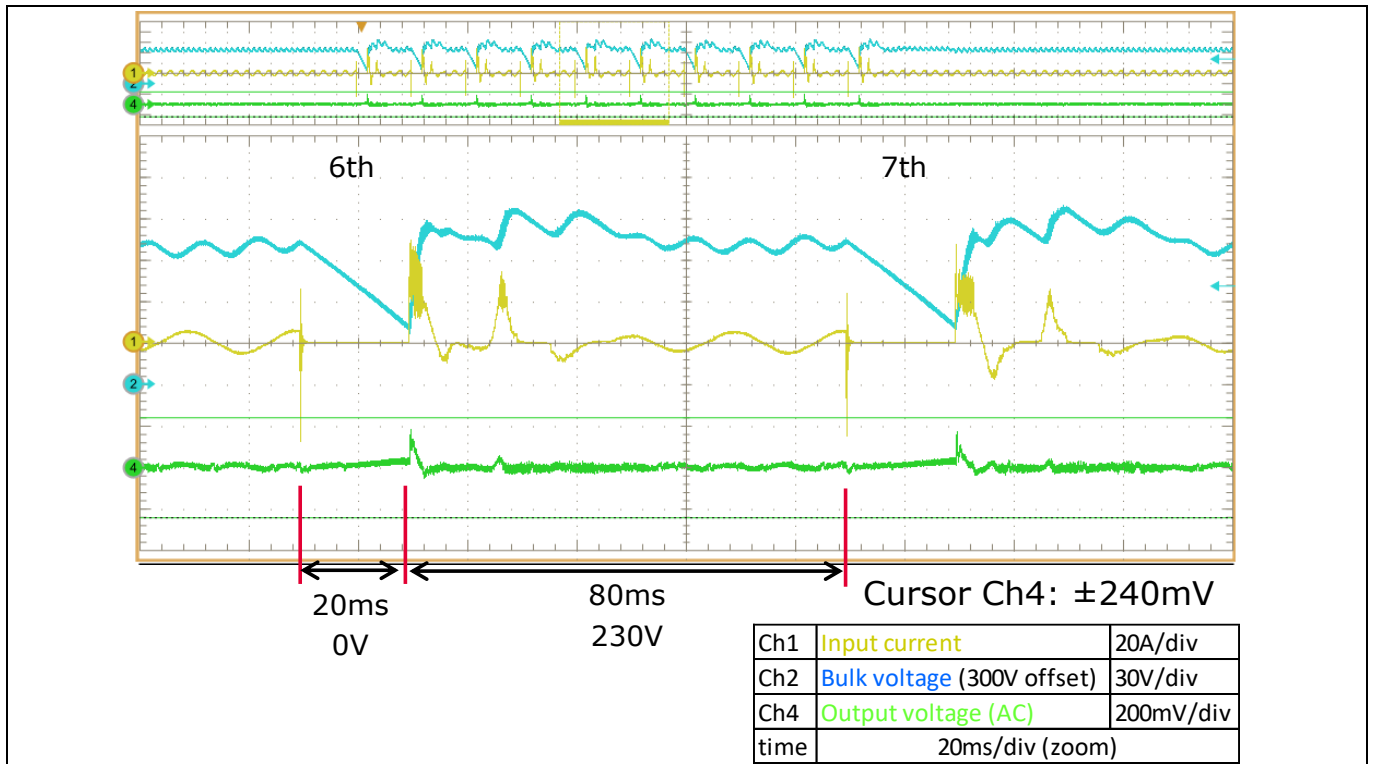


Figure 14 Detail of the 6<sup>th</sup> and 7<sup>th</sup> repetition in a 20 ms LCDO test at 230 V AC, 50 Hz and 50 percent load with a starting angle of 90 degrees

### 2.3.2 Voltage sag

For high-line, two different voltage sag conditions (Table 3) are considered and tested. Figure 15 shows the PSU behavior with voltage sag according to Table 3. As observed, the output voltage is not affected by the input voltage variation. However, if the voltage sag lasts longer than specified in the table, the power supply turns off and restarts with soft-start after an idle time. Figure 16 shows this behavior when a voltage sag to 150 V is applied for longer than 2 s.

Table 3 Voltage sag conditions applied in the 1600 W PSU test

|          |                 | 1 <sup>st</sup> to 10 <sup>th</sup> time |        |
|----------|-----------------|--|--------|
| -        | Steady AC input | Voltage sag (time)                       | Period |
| AC input | 200 V AC        | 130 V AC (0.5 s)                         | 5 s    |
|          | 200 V AC        | 150 V AC (2 s)                           | 20 s   |

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Specification and test results

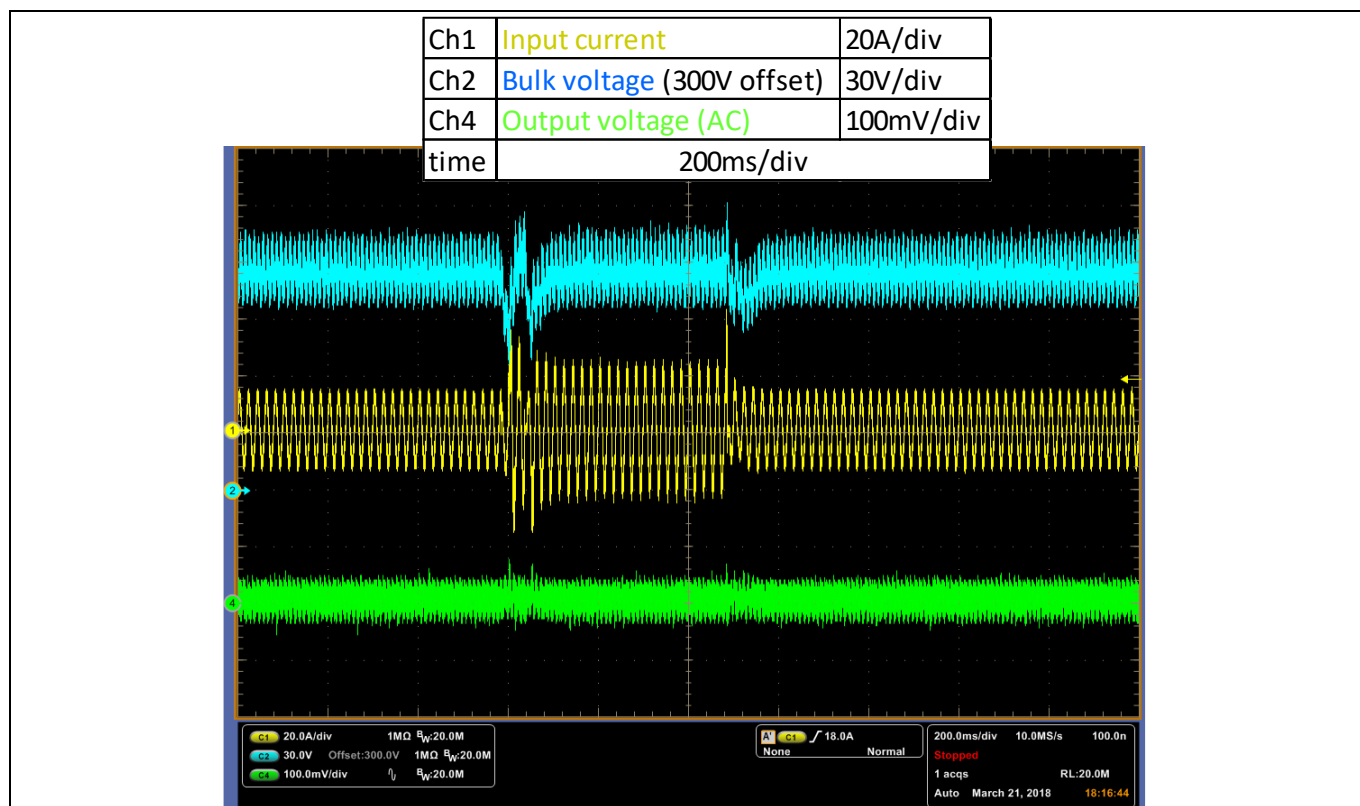


Figure 15 Main waveforms during a 500 ms and 130 V AC voltage sag at full load

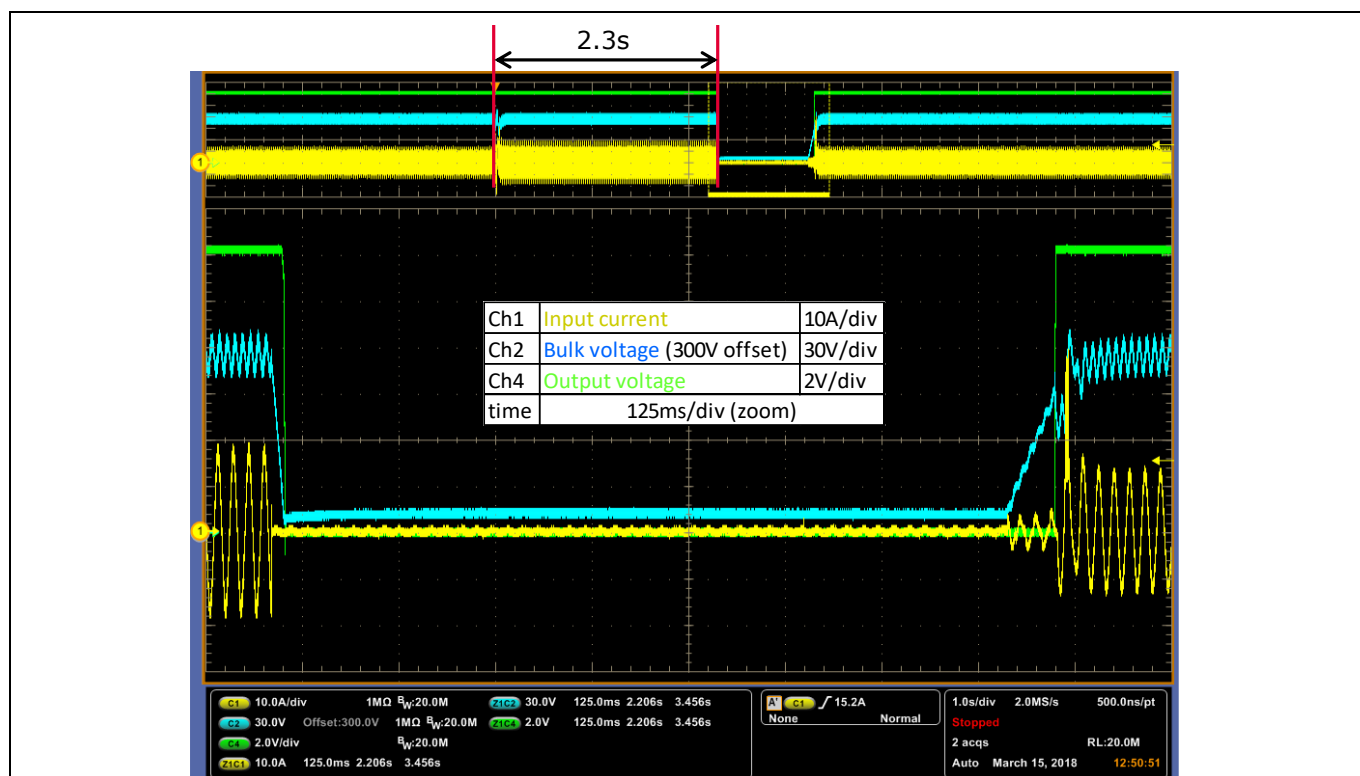


Figure 16 SMPS resumes operation after 150 V AC voltage sag applied for 3.5 seconds at full load

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### Specification and test results

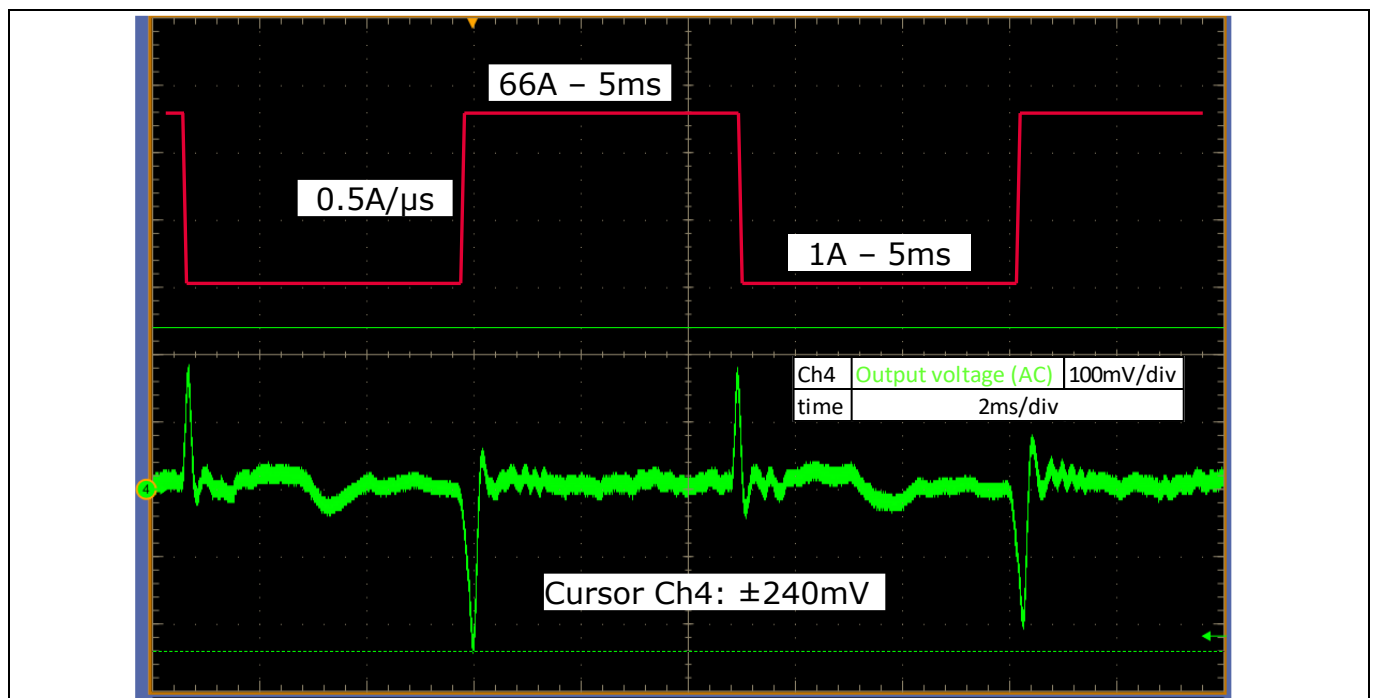
## 2.4 Output voltage dynamic behavior

In addition to power line disturbance, two other dynamic perturbances can affect the performance of the power supply shown:

- Load voltage variation
- Input voltage variation

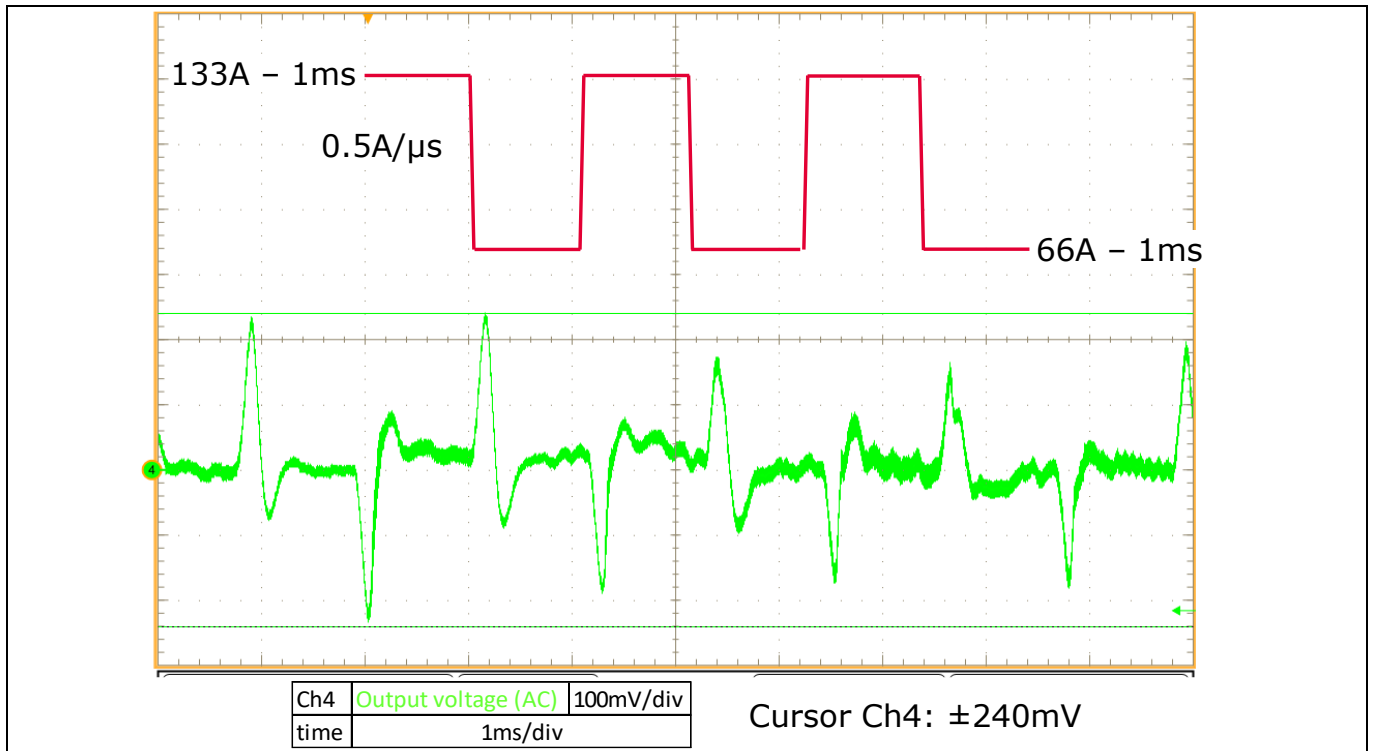
### 2.4.1 Load transient response

As specified in [Table 1](#), light-load (1 A) to half-load (66 A) and half-load to full-load (132 A) with 0.5 A/μs steps are considered. [Figure 17](#) and [Figure 18](#) show two examples for the different load steps at different repetition ratios. In all the tested cases, the output voltage dynamic ripple is within ±240 mV of the steady-state voltage of 12.2 V.



**Figure 17** Output voltage response to 1 A to 66 A dynamic load steps with 0.5 A/μs current slope every 5 ms





**Figure 18** Output voltage response to 132 A to 66 A dynamic load steps with 0.5 A/μs current slope every 1 ms

### 2.4.2 Input voltage variation

Input voltage variations, as seen in the power line disturbance section, modify the bulk voltage and ultimately affect the output voltage ripple. This can occur as well when the input voltage varies even within the normal operation range, as shown in [Figure 19](#).

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Specification and test results

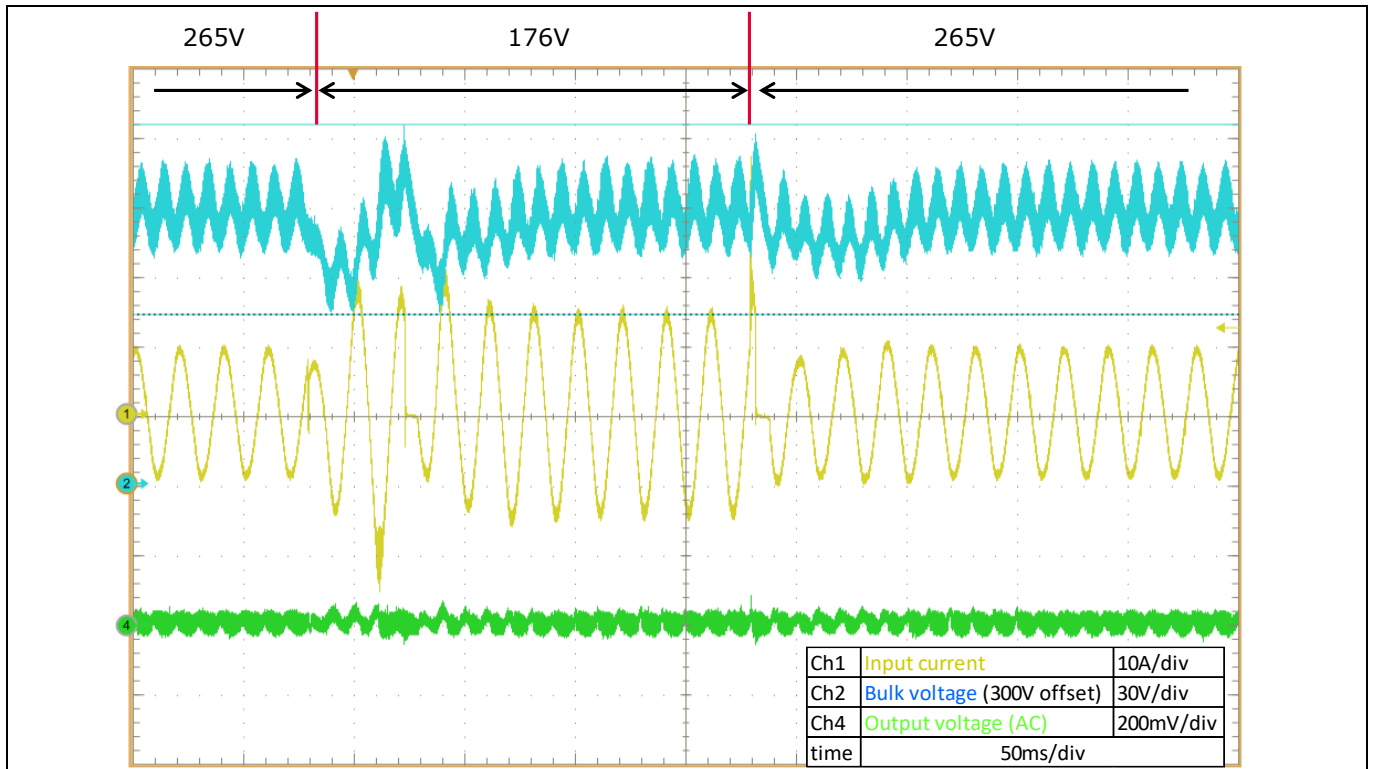


Figure 19 Maximum (265 V AC) to minimum (176 V AC) line voltage variation at full-load operation

### 2.4.3 Burst mode

The DC-DC stage of the 1600 W PSU goes into burst mode operation in light- or no-load conditions, and in those dynamic conditions where the output voltage regulation is lost due to maximum frequency limitation (300 kHz). Figure 20 shows the output voltage ripple for no-load operation of the PSU when the LLC converter is in burst mode.

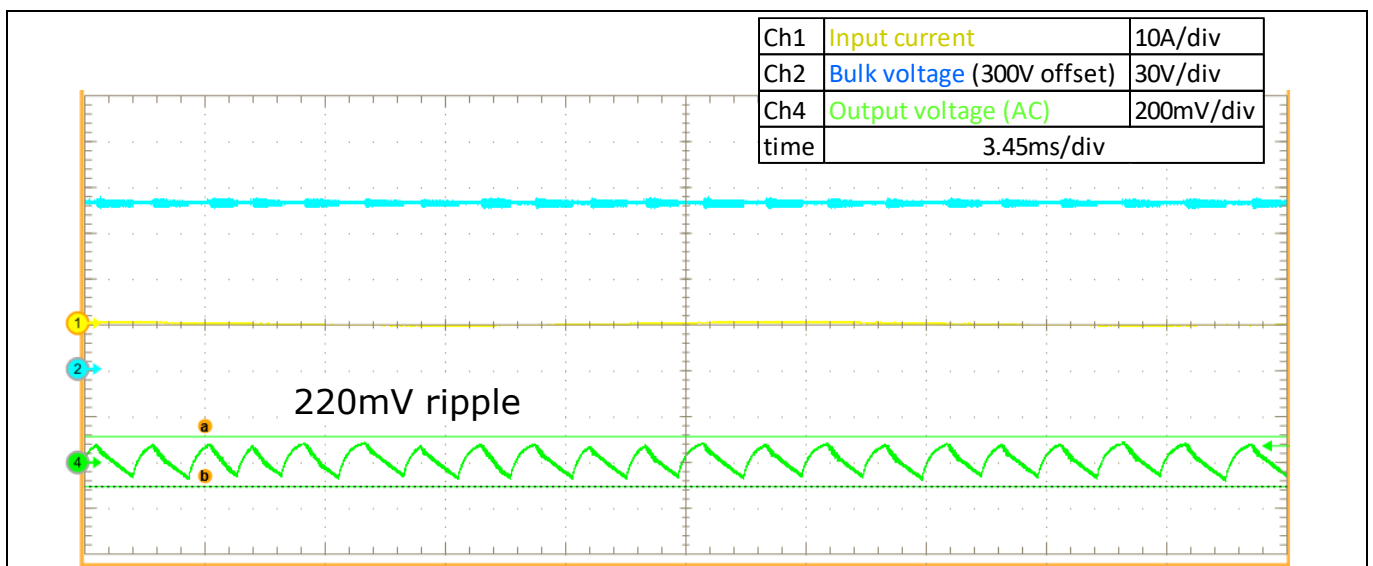


Figure 20 Output voltage ripple in burst mode at no-load operation

# 1.6 kW Titanium PSU with CoolMOS™ 600 V CFD7, Q-DPAK and XMC™

## EVAL\_1K6W\_PSU\_CFD7\_QD

### Specification and test results

## 2.5 Protections

Both stages in the 1600 W server PSU implement protections to ensure robust and reliable operation.

In the case of PFC, the brown-out protection considers the possible voltage sag as already introduced. Furthermore, average and peak inductor current limitations are implemented as well as bulk voltage monitoring for both under- and overshoot.

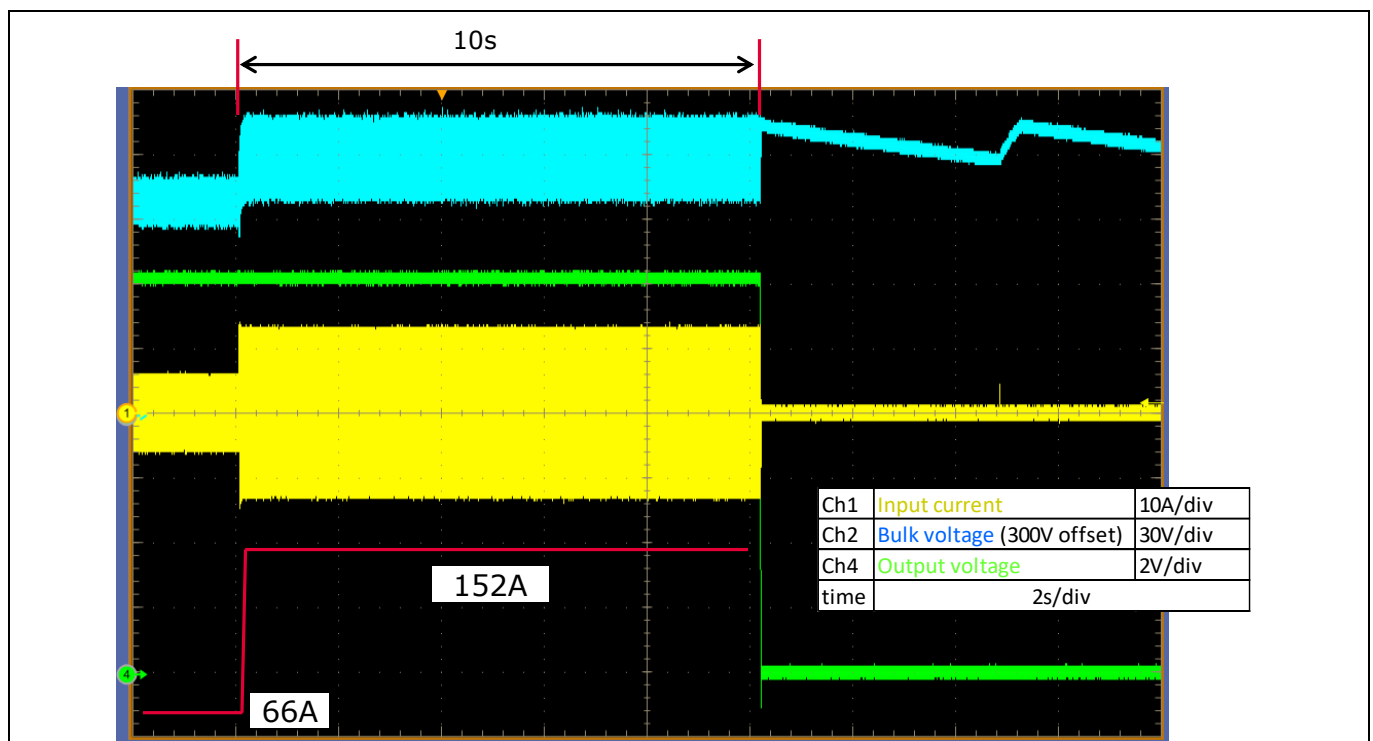
Regarding the LLC, apart from switching frequency limitation (52 kHz to 300 kHz), two main protections are implemented:

- Overcurrent
- Overvoltage

### 2.5.1 Overcurrent protection (OCP)

The programmed OCP levels together with the maximum allowed time for each level, are introduced in [Table 1](#). [Figure 21](#) shows the unit reaction to a 152 A load current. This protection latches the DC-DC converter in the PSU and the bulk voltage must go under 310 V to allow a PSU restart.

In addition, a fast short-circuit protection is implemented by comparing the resonant current with a fixed level, set to 56 A. This enables detection of a very heavy overload within a few switching cycles. The power supply can also be restarted when the bulk voltage decreases under 310 V after a short-circuit fault.



**Figure 21** LLC converter of the 1600 W SMPS shut-down due to 155 A OCP

# 1.6 kW Titanium PSU with CoolMOS™ 600 V CFD7, Q-DPAK and XMC™

## EVAL\_1K6W\_PSU\_CFD7\_QD

### Specification and test results

#### 2.5.2 Overvoltage protection (OVP)

In case of control issues in the DC-DC stage of the power supply, OVP is set to 14 V. Figure 22 shows the mentioned protection when the LLC is operated with a modified control loop, which is allowing the output voltage to reach the OVP level.

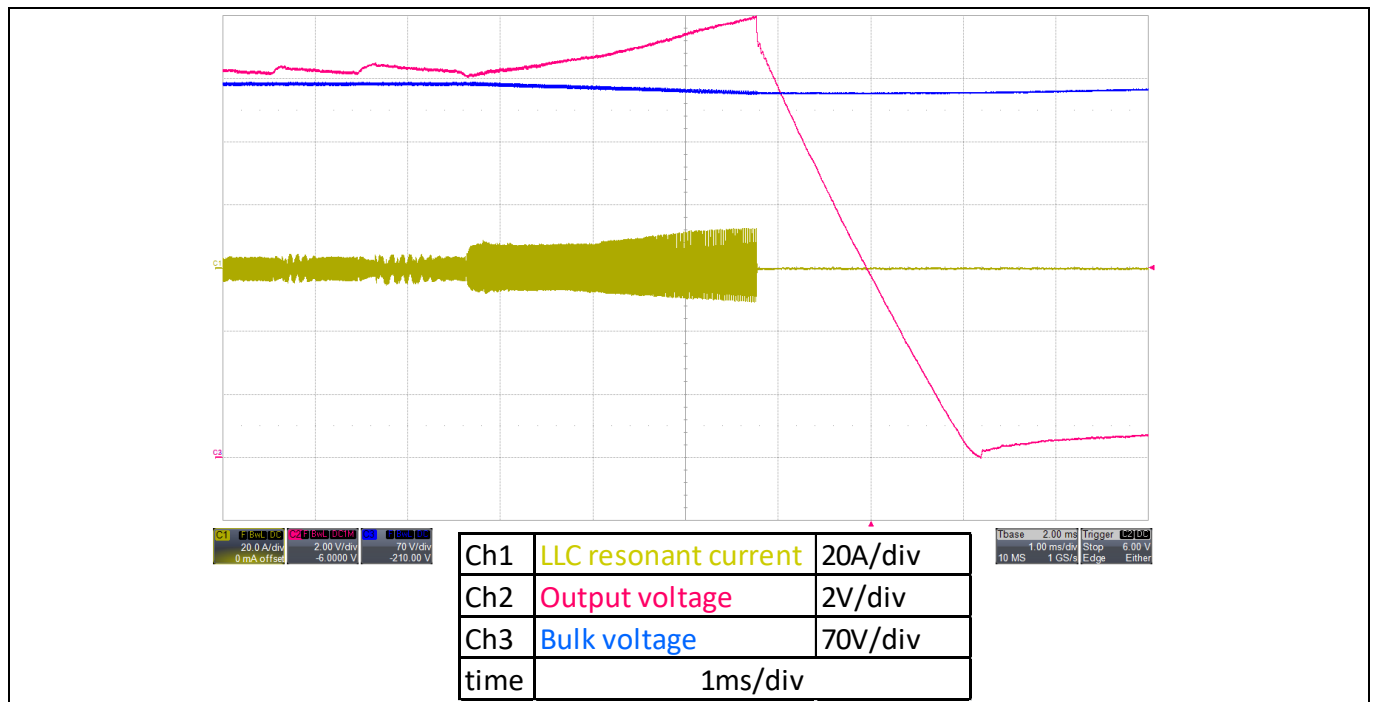


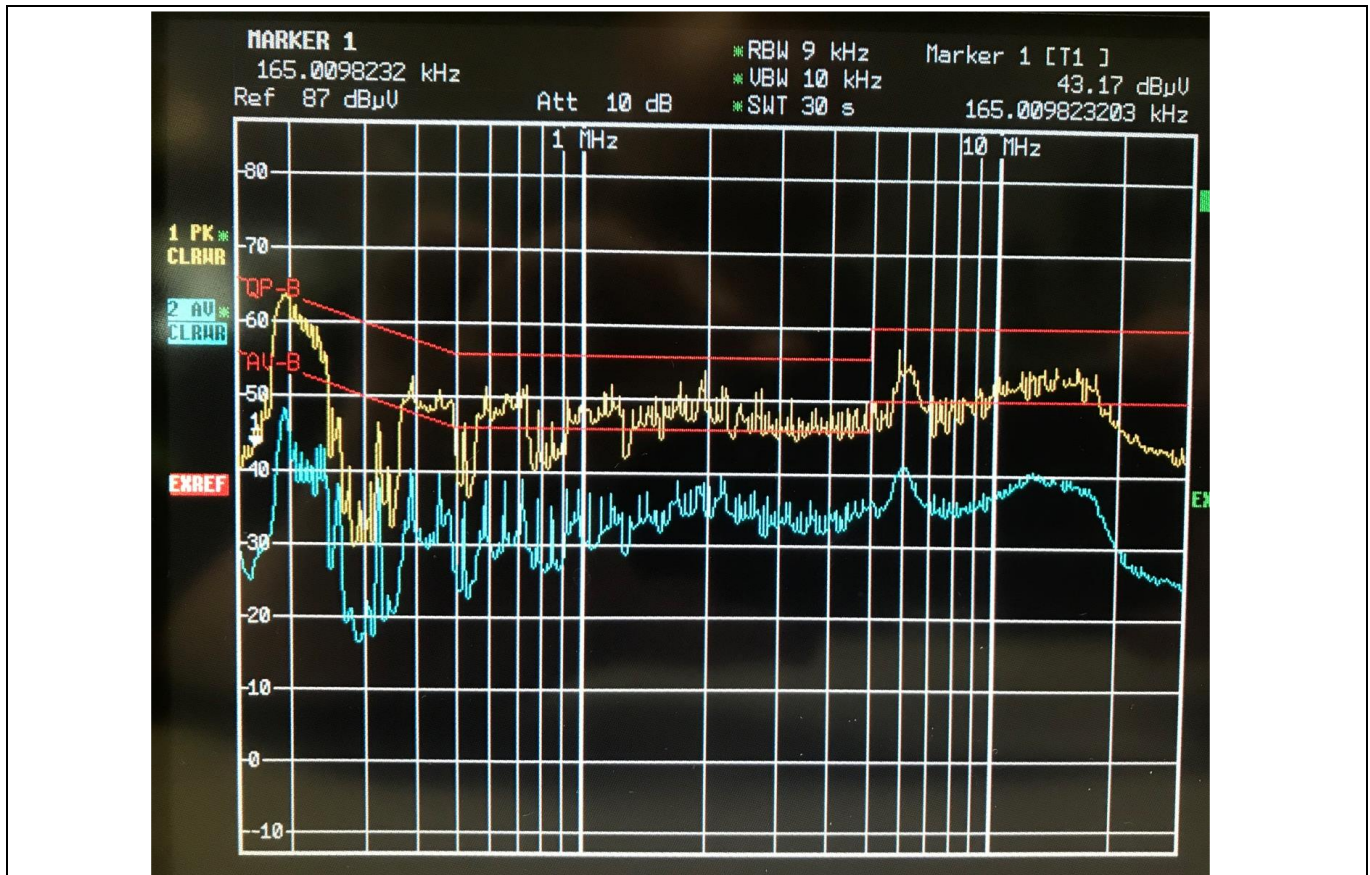
Figure 22 OVP triggered in the PSU with a modified control loop

#### 2.6 Conducted EMI

The high power density 1600 W server PSU with Q-DPAK and D-DPAK includes an EMI filter to comply with the electromagnetic emission standards. In this case, the conducted EMI complies with CISPR 22 Class B limits as shown in Figure 23. Pure resistive load is used for the conducted EMI test and the converter runs at nominal output power with nominal (230 V) input voltage at 50 Hz.

## EVAL\_1K6W\_PSU\_CFD7\_QD

### Specification and test results



**Figure 23** Measured EMI conducted emissions (yellow: quasi-peak, blue: average), compared to Class-B CISPR 22 limits, at 230 V AC input and 1600 W output resistive load

## 2.7 Thermal measurements

A long-time test has been run with attached Type K thermocouples to the main devices of EVAL\_1K6W\_PSU\_CFD7\_QD. The test has been run for nominal input voltage (230 V<sub>RMS</sub>) as well as the minimum input voltage (176 V<sub>rms</sub>), which is the worst case for the PFC operation. In both cases, nominal load (132 A at 12.2 V output) has been applied during the test at room temperature. The tested unit was enclosed and the fan was controlled by the secondary side controller according to the heatsink temperature and supplied from the server power supply output.

The results presented in this section provide the thermal performance of the 1600 W server power supply with TSC Infineon power semiconductors introduced in this document. [Figure 24](#) shows the measured temperatures for different parts of the PSU:

- **PFC switch:** Both CoolMOS™ in the back-to-back configuration were monitored and the hottest device during the test is presented
- **PFC diode:** In this case, one of the two CoolSiC™ diodes has been measured
- **PFC choke**
- **Low-side CoolMOS™ of the LLC half-bridge**
- **LLC transformer**

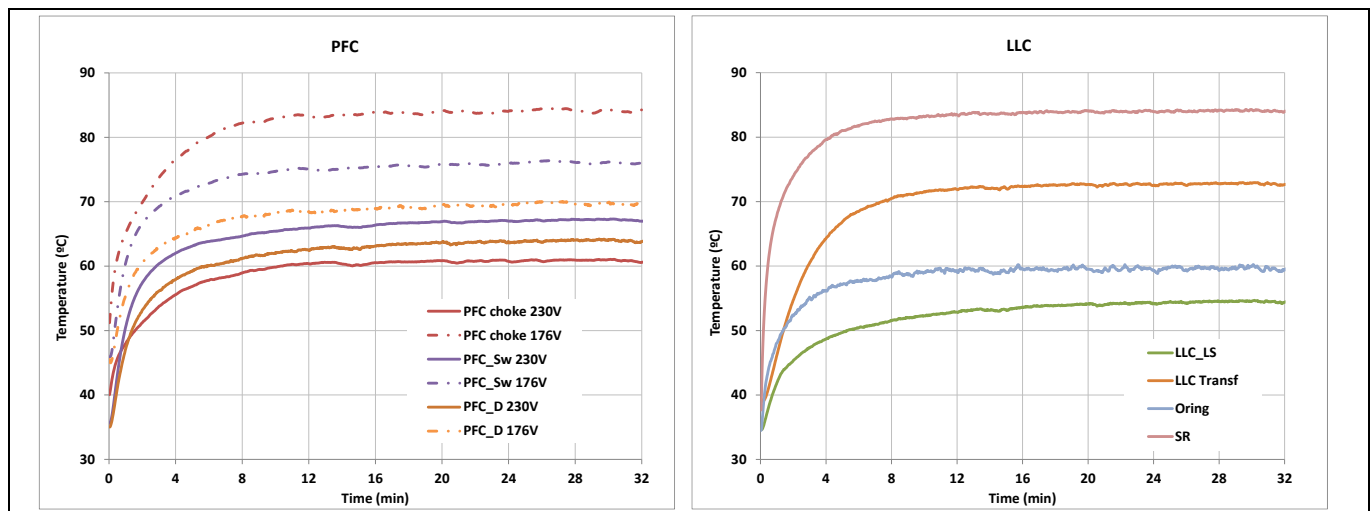
# 1.6 kW Titanium PSU with CoolMOS™ 600 V CFD7, Q-DPAK and XMC™

## EVAL\_1K6W\_PSU\_CFD7\_QD

### Specification and test results

- **LLC synchronous rectifiers:** The measurement was made for one device from both SR branches and the worst case is shown
- **Oring switch:** As in the SR case, one of the paralleled devices has been sampled in these measurements

Since the LLC input is regulated by the AC-DC stage, no temperature difference is expected when changing the input AC voltage as shown in Figure 24 (right). In the case of the PFC, it is clear that the worst case is the lowest AC voltage (dashed line on Figure 24 – left) due to the higher current in the circuit. In that case, the PFC choke is the hottest point of the PFC. In the nominal voltage case (solid lines), the PFC switch is the hottest spot of the PFC. The maximum temperature in both PFC and LLC is in the same range (about 85°C), which provides margin enough in case the ambient temperature increases.



**Figure 24** Temperature evolution for PFC (left) and LLC (right) during long-term test of EVAL\_1K6W\_PSU\_CFD7\_QD at room temperature.

## 3 Summary

This document presents a 1600 W server PSU (EVAL\_1K6W\_PSU\_CFD7\_QD) which complies with the 80 PLUS Titanium efficiency standard — efficiency is over 96 percent at 50 percent load. The achieved power density is 44 W/in<sup>3</sup>, which is enabled by the use of SMD packages.

The top-side cooling Q-DPAK and D-DPAK packages are utilized in a power board, which allows reduced commutation loops. Furthermore, the combination of these packages with CoolMOS™ CFD7 and G7 and CoolSiC™ G6 diode technologies enables mounting all the semiconductors in the same heatsink. As a result, a high-performance server power supply with a considerable increase in power density is presented in this document.

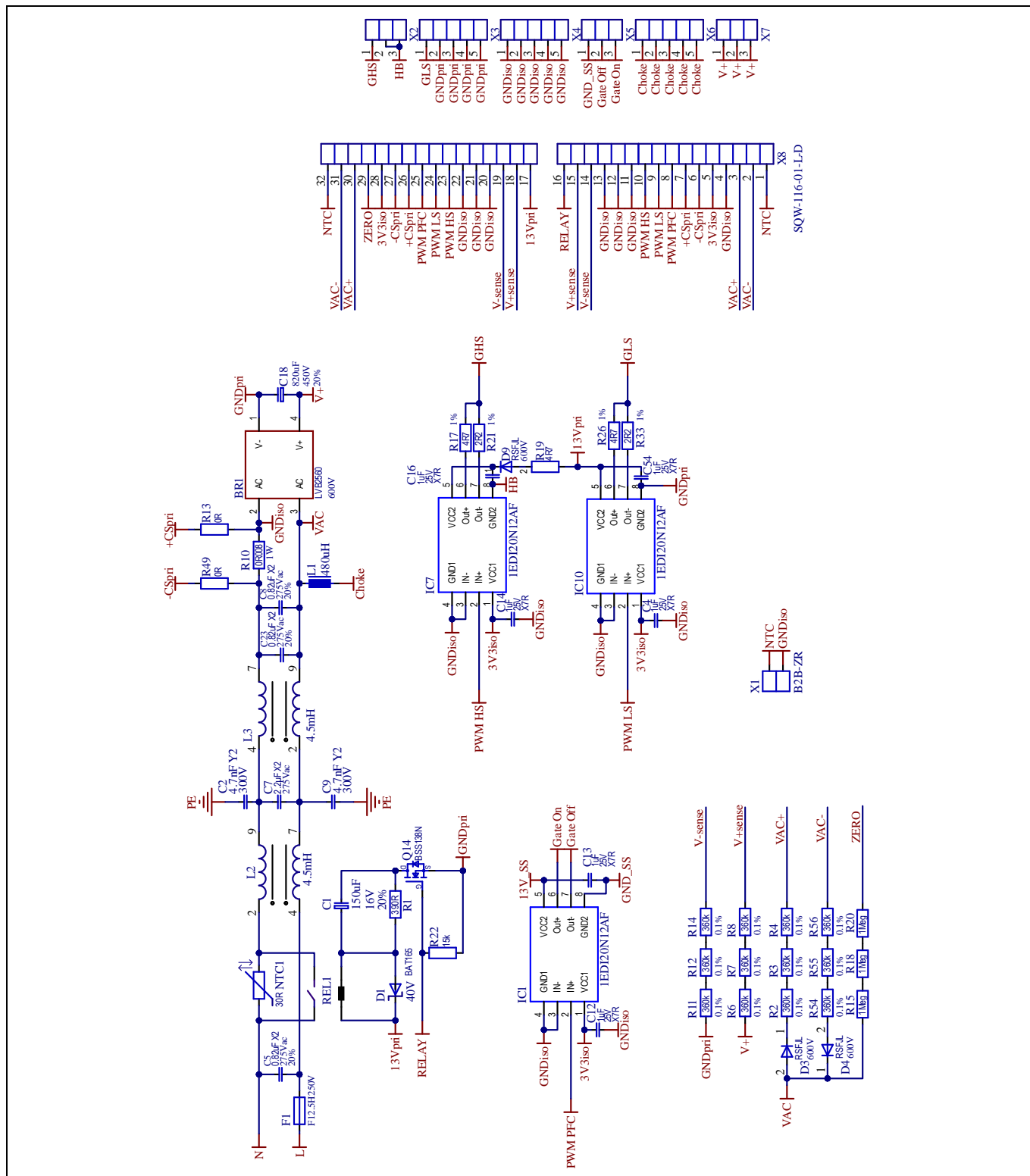
The presented board does not only provide excellent efficiency and high power density, but it also implements different input and output current and voltage protections and complies with typical server specifications in terms of input current quality or dynamic load changes. Furthermore, the 1600 W PSU presents a robust performance under AC abnormal conditions, such as voltage sag and line cycle drop out.

# 1.6 kW Titanium PSU with CoolMOS™ 600 V CFD7, Q-DPAK and XMC™

## EVAL\_1K6W\_PSU\_CFD7\_QD

### Schematics

#### 4 Schematics



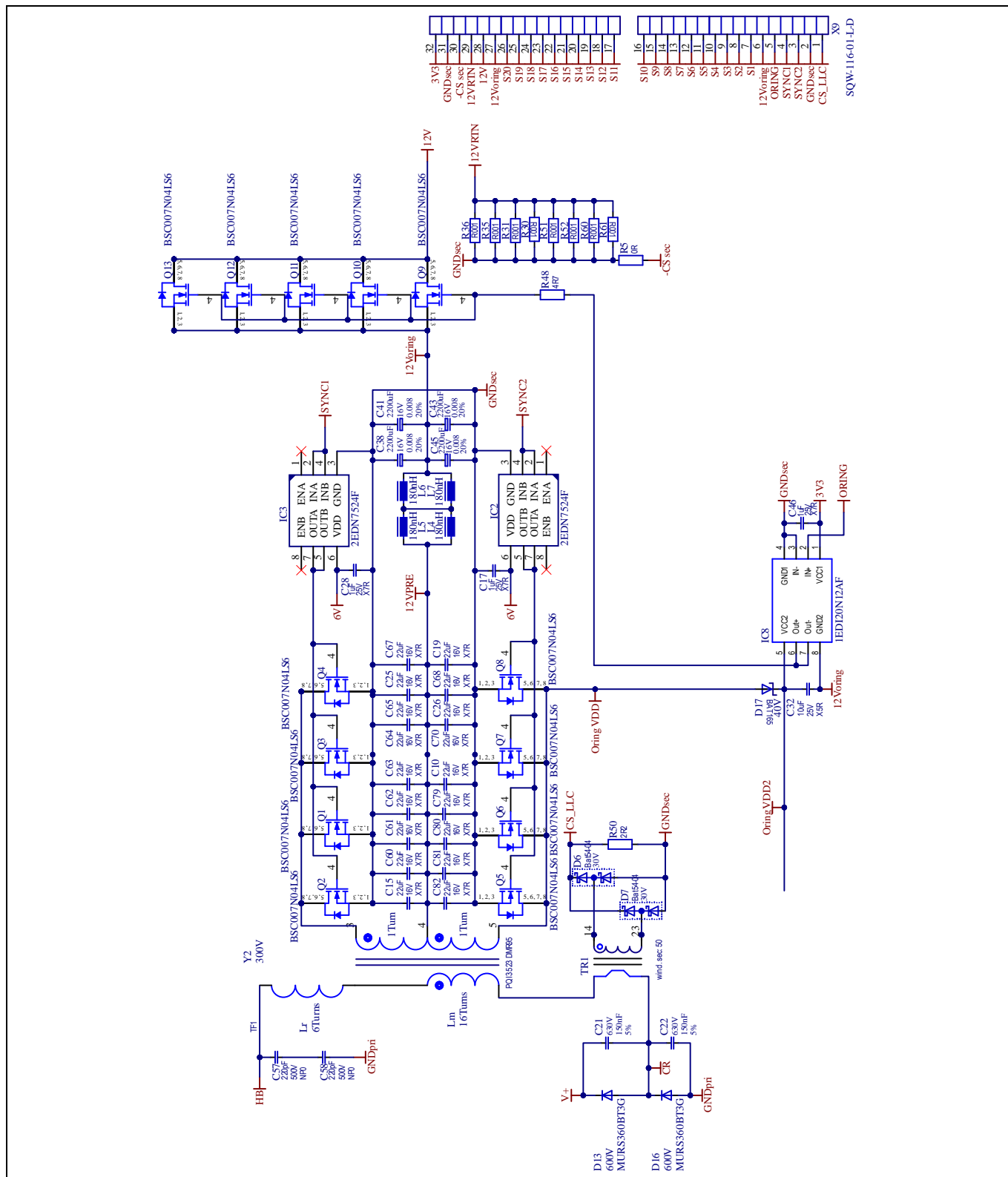
**Figure 25** PFC schematic of EVAL\_1K6W\_PSU\_CFD7\_QD, which includes the NTC, power board and primary-side control board connectors, as well as the PFC and LLC half-bridge drivers. The PFC switch and diode are in the power board



# 1.6 kW Titanium PSU with CoolMOS™ 600 V CFD7, Q-DPAK and XMC™

## EVAL\_1K6W\_PSU\_CFD7\_QD

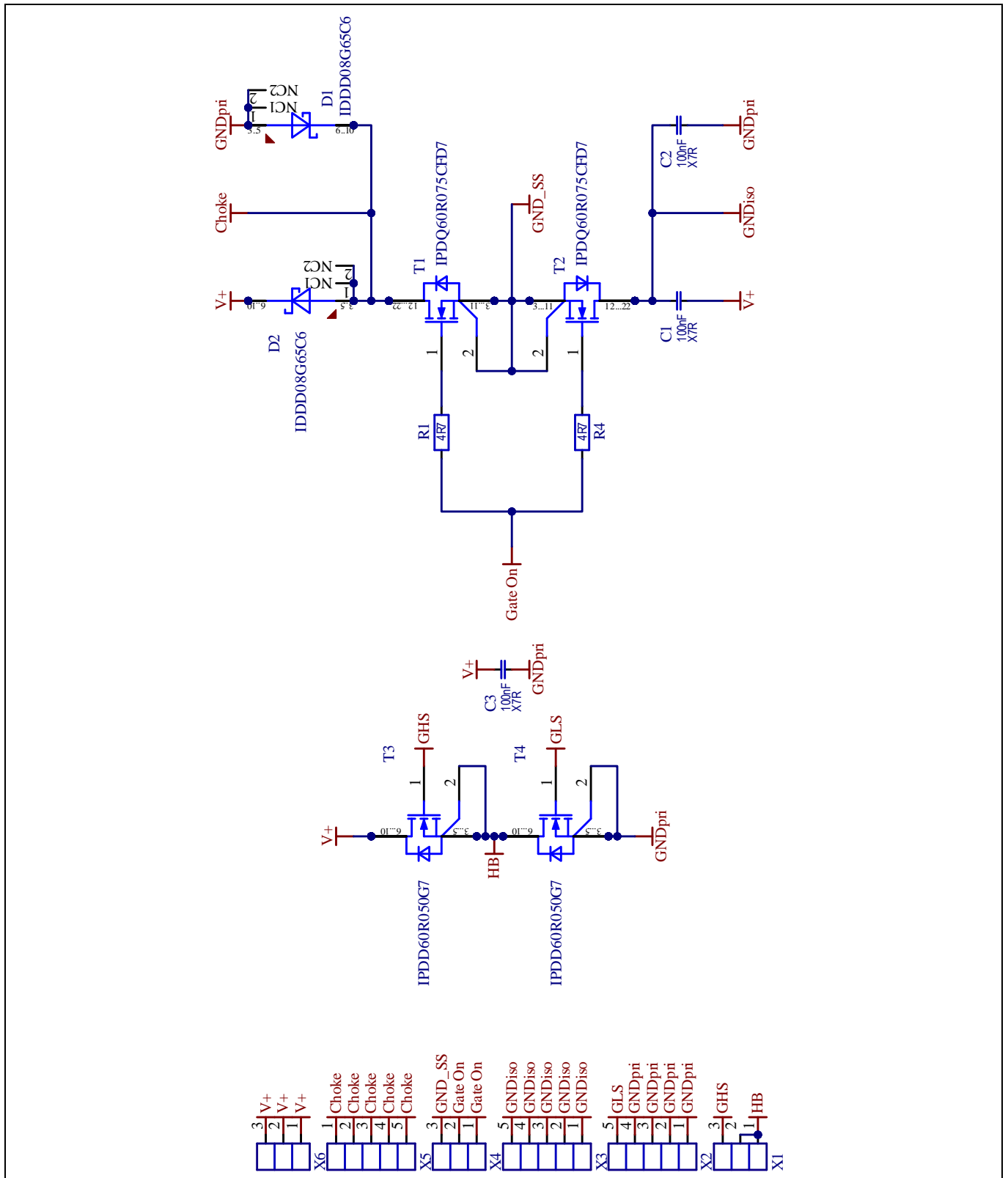
### Schematics



**Figure 26** LLC schematic of EVAL\_1K6W\_PSU\_CFD7\_QD with the secondary-side control board connector. The primary-side switches and drivers are in the power board and PFC schematic

# 1.6 kW Titanium PSU with CoolMOS™ 600 V CFD7, Q-DPAK and XMC™

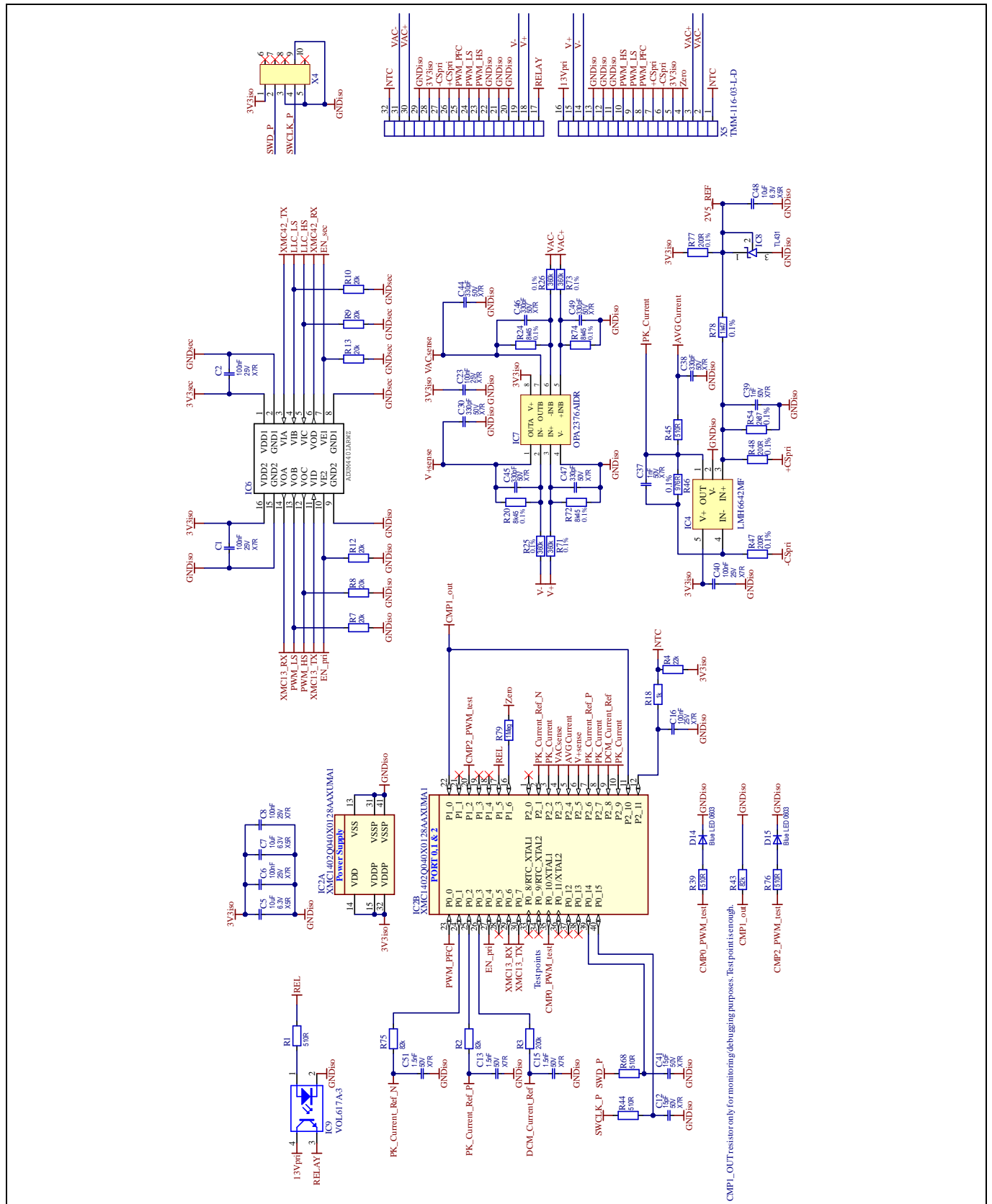
## EVAL\_1K6W\_PSU\_CFD7\_QD Schematics



**Figure 27** Power board schematic for the TSC Q-DPAK and D-DPAK power semiconductors of EVAL\_1K6W\_PSU\_CFD7\_QD

# 1.6 kW Titanium PSU with CoolMOS™ 600 V CFD7, Q-DPAK and XMC™

## EVAL\_1K6W\_PSU\_CFD7\_QD Schematics

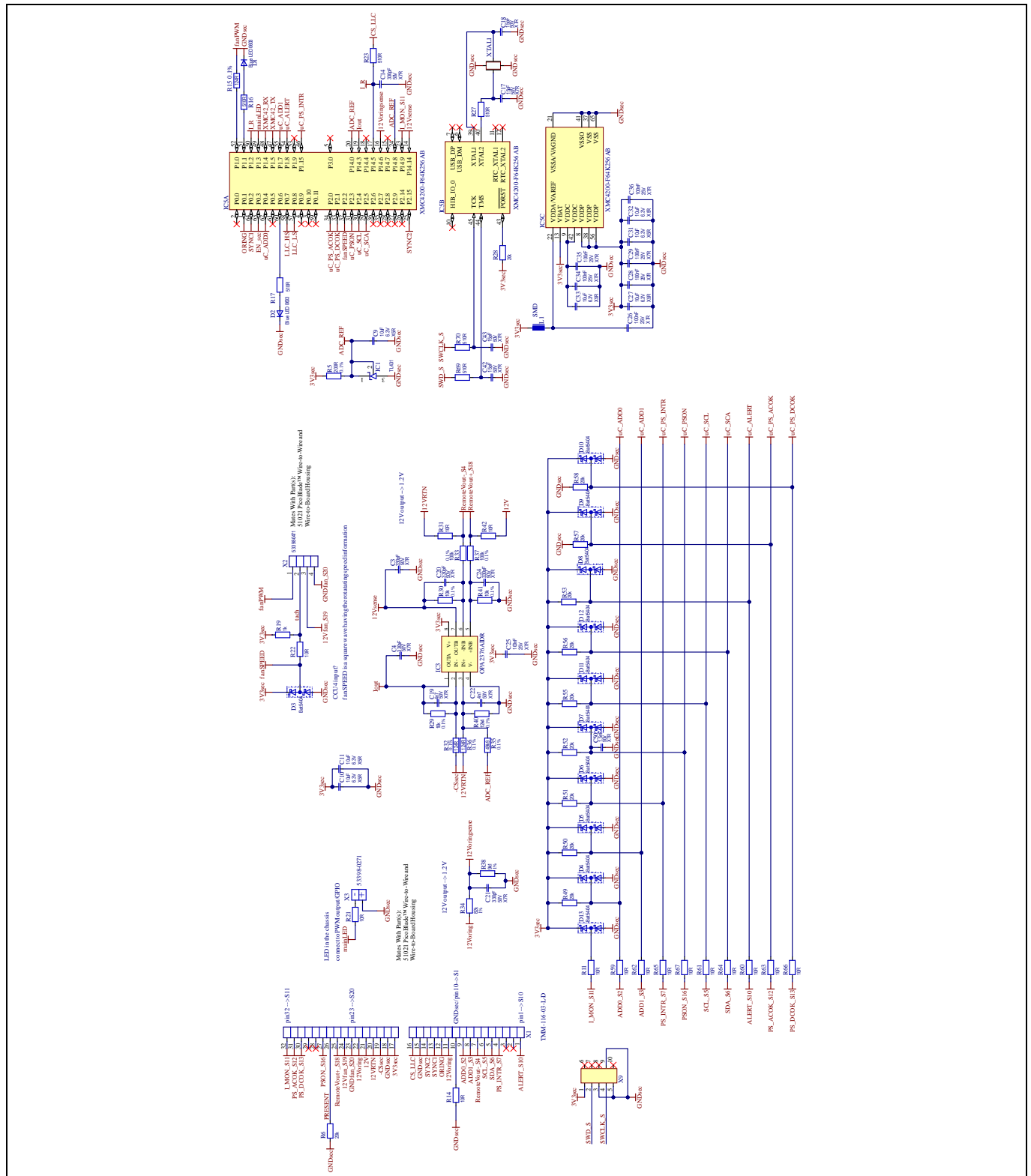


**Figure 28 Primary-side controller (XMC1402) schematic, including the digital isolator for primary-secondary communication**

# 1.6 kW Titanium PSU with CoolMOS™ 600 V CFD7, Q-DPAK and XMC™

## EVAL\_1K6W\_PSU\_CFD7\_QD

### Schematics



**Figure 29 Secondary-side controller (XMC4200) schematic, including the signaling for the PSU output connector**

# 1.6 kW Titanium PSU with CoolMOS™ 600 V CFD7, Q-DPAK and XMC™

## EVAL\_1K6W\_PSU\_CFD7\_QD

### Schematics

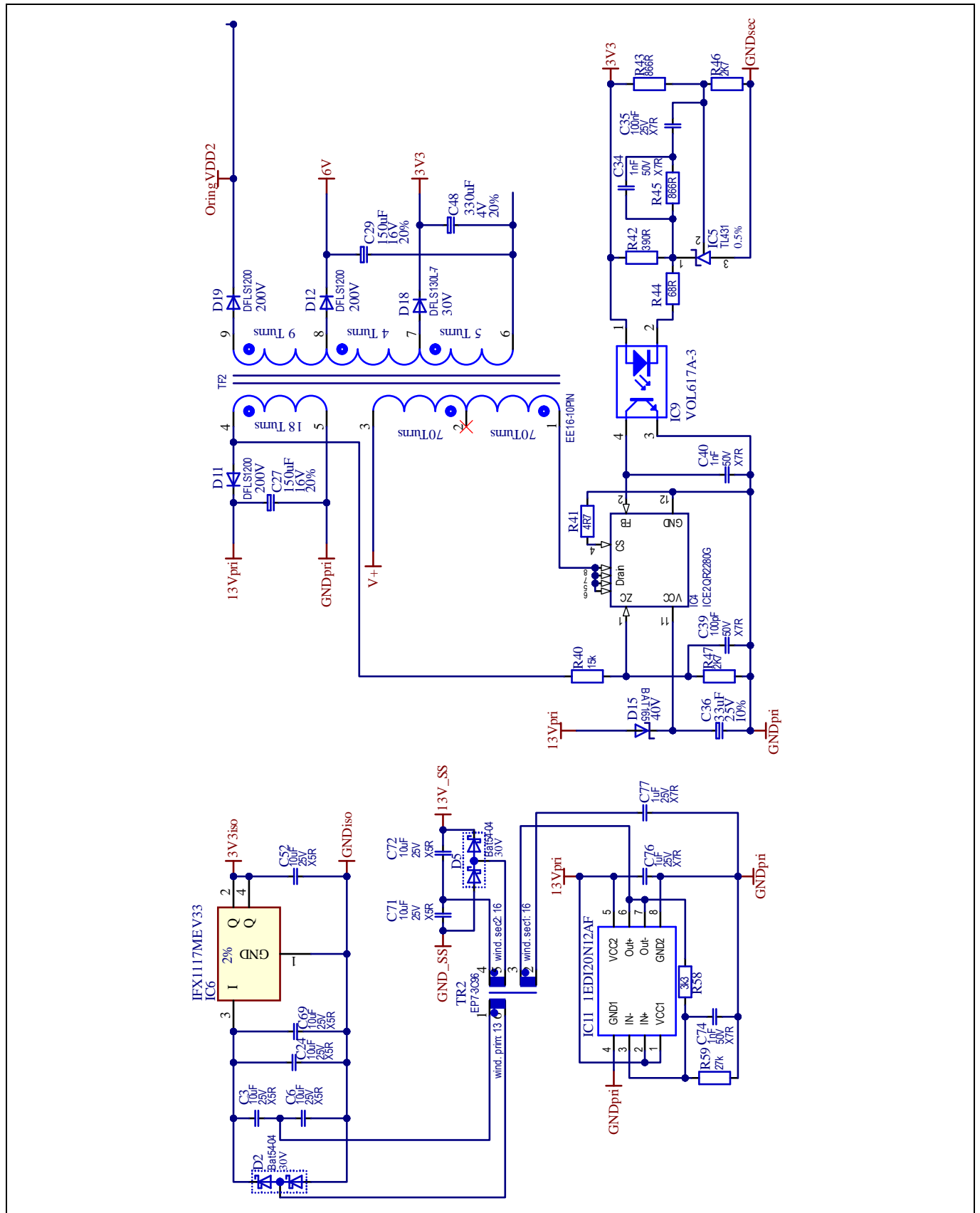


Figure 30 Auxiliary power supply (bias) of EVAL\_1K6W\_PSU\_CFD7\_QD

EVAL\_1K6W\_PSU\_CFD7\_QD

Bill of materials (BoM)

## 5 Bill of materials (BoM)

Table 4 Main board components

| Designator  | Value         | Tolerance   | Voltage | Description        | Comment |
|---|---------------|-------------|---------|--------------------|---------|
| IC2, IC3  | 2EDN7524F     | –           | –       | Integrated circuit | SMD     |
| IC1, IC7, IC8, IC10, IC11                                 | 1EDI20N12AF   | –           | –       | Integrated circuit | SMD     |
| IC4   | ICE2QR2280G   | –           | –       | Integrated circuit | SMD     |
| IC6   | IFX1117ME V33 | 2 percent   | 15 V    | Integrated circuit | SMD     |
| NTC1  | 30 R          | 20 percent  | –       | NTC resistor       | THT     |
| R1  | 390 R         | 1 percent   | –       | Resistor           | SMD     |
| R10   | 0R008         | 1 percent   | –       | Resistor           | SMD     |
| R42   | 390 R         | 1 percent   | –       | Resistor           | SMD     |
| R44   | 68 R          | 1 percent   | –       | Resistor           | SMD     |
| R58   | 3k3           | 1 percent   | –       | Resistor           | SMD     |
| R59   | 27 k          | 1 percent   | –       | Resistor           | SMD     |
| R2, R3, R4, R6, R7, R8, R11,<br>R12, R14, R54, R55, R56   | 360 k         | 0.1 percent | –       | Resistor           | SMD     |
| R22, R40  | 15 k          | 1 percent   | –       | Resistor           | SMD     |
| R43, R45  | 866 R         | 1 percent   | –       | Resistor           | SMD     |
| R46, R47  | 2K7           | 1 percent   | –       | Resistor           | SMD     |
| R15, R18, R20   | 1 Meg         | 1 percent   | –       | Resistor           | SMD     |
| R21, R33, R50   | 2R2           | 1 percent   | –       | Resistor           | SMD     |
| R5, R13, R49  | 0 R           | 1 percent   | –       | Resistor           | SMD     |
| R17, R19, R26, R41, R48                                   | 4R7           | 1 percent   | –       | Resistor           | SMD     |
| R30, R31, R35, R36, R51, R52,<br>R60, R61                 | R001          | 1 percent   | –       | Resistor           | SMD     |
| REL1  | OJE-SS-112HM  | –           | 12 V    | Relay              | THT     |
| Q14   | BSS138N       | –           | 60 V    | MOSFET             | SMD     |
| Q1, Q2, Q3, Q4, Q5, Q6, Q7,<br>Q8, Q9, Q10, Q11, Q12, Q13 | BSC007N04LS6  | –           | 40 V    | MOSFET             | SMD     |
| L1  | 480 µH        | –           | –       | Magnetic           | THT     |
| TF1   | PQI3523 DMR95 | –           | –       | Magnetic           | THT     |
| TF2   | EE16-10PIN    | –           | –       | Magnetic           | THT     |
| TR1   |               | –           | –       | Magnetic           | THT     |
| TR2   | EP7-3C96      | –           | –       | Magnetic           | THT     |
| L2, L3  | 4.5 mH        | –           | –       | Magnetic           | THT     |
| L4, L5, L6, L7  | 180 nH        | –           | –       | Magnetic           | SMD     |
| IC5   | TL431         | 0.5 percent | –       | Integrated circuit | SMD     |
| IC9   | VOL617A-3     | –           | –       | Integrated circuit | SMD     |

# 1.6 kW Titanium PSU with CoolMOS™ 600 V CFD7, Q-DPAK and XMC™



## EVAL\_1K6W\_PSU\_CFD7\_QD

### Bill of materials (BoM)

| Designator  | Value          | Tolerance  | Voltage  | Description         | Comment |
|---|----------------|------------|----------|---------------------|---------|
| F1  | F12.5H250V     | -          | -        | Fuse                | THT     |
| D1, D8, D15, D17  | BAT165         | -          | 40 V     | Schottky diode      | SMD     |
| D2, D5, D6, D7  | BAT54-04       | -          | 30 V     | Schottky diode      | SMD     |
| BR1   | LVB2560        | -          | 600 V    | Bridge diode        | THT     |
| D18   | DFLS130L-7     | -          | 30 V     | Diode               | SMD     |
| D13, D16  | MURS360BT3G    | -          | 600 V    | Diode               | SMD     |
| D11, D12, D19   | DFLS1200       | -          | 200 V    | Diode               | SMD     |
| D3, D4, D9  | RSFJL          | -          | 600 V    | Diode               | SMD     |
| X1  | B2B-ZR         | -          | -        | Connector           | THT     |
| X8, X9  | SQW-116-01-L-D | -          | -        | Connector           | THT     |
| C18   | 820 µF         | 20 percent | 450 V    | Polarized capacitor | THT     |
| C36   | 33 µF          | 10 percent | 25 V     | Polarized capacitor | SMD     |
| C48   | 330 µF         | 20 percent | 4 V      | Polarized capacitor | SMD     |
| C1, C27, C29  | 150 µF         | 20 percent | 16 V     | Polarized capacitor | SMD     |
| C30, C38, C41, C43, C45   | 2200 µF        | 20 percent | 16 V     | Polarized capacitor | THT     |
| C7  | 2.2 µF X2      | 20 percent | 275 V AC | Foil capacitor      | THT     |
| C21, C22  | 150 nF         | 5 percent  | 630 V    | Foil capacitor      | THT     |
| C5, C8, C23   | 0.82 µF X2     | 20 percent | 275 V AC | Foil capacitor      | THT     |
| C35   | 100 nF         | X7R        | 25 V     | Ceramic capacitor   | SMD     |
| C39   | 100 pF         | X7R        | 50 V     | Ceramic capacitor   | SMD     |
| C4, C12, C13, C14, C16, C17, C28, C46, C54, C76, C77  | 1 µF           | X7R        | 25 V     | Ceramic capacitor   | SMD     |
| C31, C33  | 100 nF         |            | 500 V    | Ceramic capacitor   | SMD     |
| C57, C58  | 220 pF         | NP0        | 500 V    | Ceramic capacitor   | SMD     |
| C10, C11, C15, C19, C20, C25, C26, C37, C42, C44, C47, C49, C60, C61, C62, C63, C64, C65, C67, C68, C70, C79, C80, C81, C82 | 22 µF          | X7R        | 16 V     | Ceramic capacitor   | SMD     |
| C2, C9, C56   | 4.7 nF         | Y2         | 300 V    | Ceramic capacitor   | THT     |
| C34, C40, C74   | 1 nF           | X7R        | 50 V     | Ceramic capacitor   | SMD     |
| C3, C6, C24, C32, C52, C69, C71, C72  | 10 µF          | X5R        | 25 V     | Ceramic capacitor   | SMD     |

# 1.6 kW Titanium PSU with CoolMOS™ 600 V CFD7, Q-DPAK and XMC™



## EVAL\_1K6W\_PSU\_CFD7\_QD

### Bill of materials (BoM)

**Table 5 Power board components**

| Designator | Value           | Tolerance | Voltage | Description                                       | Comment |
|------------|-----------------|-----------|---------|---|---------|
| T1, T2     | IPQD60R075CDF7  | -         | -       | 600 V CoolMOS™ CFD7 power transistor, 600 V (VDS) | SMD     |
| T3, T4     | IPDD60R050G7    | -         | -       | 600 V CoolMOS™ G7 power transistor, 600 V (VDS)   | SMD     |
| D1, D2     | IDDD08G65C6     | -         | -       | 650 V CoolSiC™ G6 Schottky diode                  | SMD     |
| R1, R4     | 10 R            | 1 percent |         | Resistor  | SMD     |
| C1, C2, C3 | 100 nF          | -         | 500 V   | Ceramic capacitor                                 | SMD     |
| X1, X4, X6 | MMT-103-01-L-SH | -         | -       | Connector   | SMD     |
| X2, X3, X5 | MMT-105-01-L-SH | -         | -       | Connector   | SMD     |

**Table 6 Control board components**

| Designator   | Value                    | Tolerance | Voltage | Description        | Comment           |     |
|--|--------------------------|-----------|---------|--------------------|-------------------|-----|
| IC2  | XMC1402-Q040X0128AAXUMA1 | -         | -       | Integrated circuit | SMD               |     |
| IC5  | XMC4200-F64K256AB        | -         | -       | Integrated circuit | SMD               |     |
| C1, C2, C6, C8, C16, C23, C25, C26, C28, C29, C34, C35, C36, C40 | 100 nF                   |           | X7R     | 25 V               | Ceramic capacitor | SMD |
| C3, C4, C14, C20, C21, C24, C30, C38, C44, C45, C46, C47, C49    | 330 pF                   |           | X7R     | 50 V               | Ceramic capacitor | SMD |
| C5, C7, C9, C10, C11, C27, C31, C32, C33, C48                    | 10 µF                    |           | X5R     | 6.3 V              | Ceramic capacitor | SMD |
| C12, C17, C18, C41, C42, C43                                     | 15 pF                    |           | X7R     | 50 V               | Ceramic capacitor | SMD |
| C13, C15, C50, C51   | 1.5 nF                   |           | X7R     | 50 V               | Ceramic capacitor | SMD |
| C19, C22   | 4 n7                     |           | X7R     | 50 V               | Ceramic capacitor | SMD |
| C37, C39   | 1 nF                     |           | X7R     | 50 V               | Ceramic capacitor | SMD |
| D1, D2, D14, D15   | Blue LED 0603            | -         | -       | LED diode          | SMD               |     |
| D3, D4, D5, D6, D7, D8, D9, D10, D11, D12, D13                   | BAT54-04                 | -         | -       | Diode              | SMD               |     |
| IC1, IC8   | TL431                    | -         | -       | Integrated circuit | SMD               |     |
| IC3, IC7   | OPA2376AIDR              | -         | -       | Integrated circuit | SMD               |     |
| IC4  | LMH6642MF                | -         | -       | Integrated circuit | SMD               |     |
| IC6  | ADUM4401ARWZ             | -         | -       | Integrated circuit | SMD               |     |



# 1.6 kW Titanium PSU with CoolMOS™ 600 V CFD7, Q-DPAK and XMC™



## EVAL\_1K6W\_PSU\_CFD7\_QD

### Bill of materials (BoM)

| Designator  | Value                        | Tolerance   | Voltage | Description        | Comment |
|---|------------------------------|-------------|---------|--------------------|---------|
| IC9   | VOL617A-3                    | -           | -       | Integrated circuit | SMD     |
| L1  | Ferrite bead 60 Ω at 100 mHz | -           | -       | Magnetic           | SMD     |
| R1, R16, R17, R23, R27, R39, R44, R45, R68, R69, R70, R76                       | 510 R                        | 1 percent   | -       | Resistor           | SMD     |
| R2, R34, R43, R75   | 82 k                         | 1 percent   | -       | Resistor           | SMD     |
| R3  | 200 k                        | 1 percent   | -       | Resistor           | SMD     |
| R4  | 22 k                         | 1 percent   | -       | Resistor           | SMD     |
| R5, R47, R48, R77   | 200 R                        | 0.1 percent | -       | Resistor           | SMD     |
| R6, R7, R8, R9, R10, R12, R13, R28, R49, R50, R51, R52, R53, R55, R56, R57, R58 | 20 k                         | 1 percent   | -       | Resistor           | SMD     |
| R11, R14, R21, R22, R31, R42, R59, R60, R61, R62, R63, R64, R65, R66, R67       | 10 R                         | 1 percent   | -       | Resistor           | SMD     |
| R15, R32, R36   | 124 R                        | 0.1 percent | -       | Resistor           | SMD     |
| R18, R19  | 1 k                          | 1 percent   | -       | Resistor           | SMD     |
| R20, R24, R72, R74  | 8k45                         | 0.1 percent | -       | Resistor           | SMD     |
| R25, R26, R71, R73  | 360 k                        | 0.1 percent | -       | Resistor           | SMD     |
| R29, R30, R41   | 10 k                         | 0.1 percent | -       | Resistor           | SMD     |
| R33, R37  | 100 k                        | 0.1 percent | -       | Resistor           | SMD     |
| R35   | 49k9                         | 0.1 percent | -       | Resistor           | SMD     |
| R38   | 9k1                          | 1 percent   | -       | Resistor           | SMD     |
| R40   | 12k4                         | 0.1 percent | -       | Resistor           | SMD     |
| R46   | 976 R                        | 0.1 percent | -       | Resistor           | SMD     |
| R54   | 2k87                         | 0.1 percent | -       | Resistor           | SMD     |
| R78   | 1k47                         | 0.1 percent | -       | Resistor           | SMD     |
| R79   | 1 Meg                        | 1 percent   | -       | Resistor           | SMD     |

## 1.6 kW Titanium PSU with CoolMOS™ 600 V CFD7, Q-DPAK and XMC™



### EVAL\_1K6W\_PSU\_CFD7\_QD

#### Bill of materials (BoM)

| Designator | Value          | Tolerance | Voltage | Description        | Comment |
|------------|----------------|-----------|---------|--------------------|---------|
| X1, X5     | TMM-116-03-L-D | -         | -       | Connector          | SMD     |
| X2         | 53398-0471     | -         | -       | Connector          | SMD     |
| X3         | 53398-0271     | -         | -       | Connector          | SMD     |
| X4, X9     | -              | -         | -       | Connector          | SMD     |
| XTAL1      | 12 MHz         | -         | -       | Crystal oscillator | SMD     |

### References

- [1] Infineon Technologies AG; *800 W Platinum server power supply, using 600 V CoolMOS™ C7 and digital control with XMC™*; [Available online](#)
- [2] Infineon Technologies AG; *800 W Platinum® server power supply, using 600 V CoolMOS™ P7 and digital control with XMC™*; [Available online](#)
- [3] Infineon Technologies AG; *CoolMOS™ G7 and CoolSiC™ G6 will come in a new top-side cooling package – the DPAK. A new option of integration*; [Available online](#)
- [4] Infineon Technologies AG; *600 V CoolMOS™ CFD7 comes in a new top-side cooling package – the QDPAK. A further option for integration*; [Available online](#)
- [5] Infineon Technologies AG; *PFC demo board – system solution. High power density 800 W 130kHz Platinum server design*; [Available online](#)
- [6] Infineon Technologies AG; *High-efficiency 3 kW bridgeless dual-boost PFC demo board; 90 kHz digital control design based on 650 V CoolMOS™ C7 in TO-247 4-pin*; [Available online](#)
- [7] Infineon Technologies AG; *3 kW dual-phase LLC demo board; using 600 V CoolMOS™ CFD7 and digital control by XMC4400*; [Available online](#)

Others:

- [8] IEEE Transactions on Power Electronics; *Performance Evaluation of Bridgeless PFC Boost Rectifiers*; [Available online](#)

**Revision history**

| <b>Document revision</b> | <b>Date</b> | <b>Description of changes</b> |
|--------------------------|-------------|-------------------------------|
| V 1.0                    | 2024-06-24  | Initial release               |

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